

# A29160A Series

2M X 8 Bit / 1M X 16 Bit CMOS 5.0 Volt-only, Boot Sector Flash Memory

# Preliminary

# **Document Title**

2M X 8 Bit / 1M X 16 Bit CMOS 5.0 Volt-only, Boot Sector Flash Memory

# **Revision History**

Rev. No.	<u>History</u>	Issue Date	<u>Remark</u>
0.0	Initial issue	May 27, 2013	Preliminary





# 2M X 8 Bit / 1M X 16 Bit CMOS 5.0 Volt-only, Boot Sector Flash Memory

# Preliminary

#### **Features**

- Single power supply operation
  - Full voltage range: 4.5 to 5.5 volt for read and write operations
- Access times:
  - 55/70 (max.)
- Current:
  - 20 mA typical active read current
  - 30 mA typical program/erase current
  - 0.5uA typical CMOS standby ( $\overline{WP}$  = VCC or Float)
- Flexible sector architecture
  - 16 Kbyte/ 8 KbyteX2/ 32 Kbyte/ 64 KbyteX31 sectors
  - 8 Kword/ 4 KwordX2/ 16 Kword/ 32 KwordX31 sectors
  - Any combination of sectors can be erased
  - Supports full chip erase
  - Sector protection:

A hardware method of protecting sectors to prevent any inadvertent program or erase operations within that sector. Temporary Sector Unprotect feature allows code changes in previously locked sectors

- Unlock Bypass Program Command
  - Reduces overall programming time when issuing multiple program command sequence
- Top or bottom boot block configurations available
- Embedded Algorithms
  - Embedded Erase algorithm will automatically erase the entire chip or any combination of designated sectors and verify the erased sectors
  - Embedded Program algorithm automatically writes and verifies data at specified addresses

- Minimum 100,000 program/erase cycles per sector
- 10-vear data retention
  - Reliable operation for the life of the system
- CFI (Common Flash Interface) compliant
  - Provides device-specific information to the system, allowing host software to easily reconfigure for different Flash devices
- Compatible with JEDEC-standards
  - Pinout and software compatible with single-power-supply Flash memory standard
  - Superior inadvertent write protection
- Data Polling and toggle bits
  - Provides a software method of detecting completion of program or erase operations
- Ready / BUSY pin (RY / BY)
  - Provides a hardware method of detecting completion of program or erase operations
- Erase Suspend/Erase Resume
  - Suspends a sector erase operation to read data from, or program data to, a non-erasing sector, then resumes the erase operation
- Hardware reset pin (RESET)
  - Hardware method to reset the device to reading array data
- WP input pin (48 pins TSOP, TFBGA)
  - At V<sub>IL</sub>, protects the 16Kbyte boot sector from erasure regardless of sector protect/unprotect status.
  - At V<sub>IH</sub>, allows removal of boot sector protection.
- Package options
  - 48-pin TSOP (I) or 48-ball TFBGA
  - All Pb-free (Lead-free) products are RoHS compliant

#### **General Description**

The A29160A is a 16Mbit, 5.0 volt-only Flash memory organized as 2.097.152 bytes of 8 bits or 1.048.576 words of 16 bits each. The 8 bits of data appear on I/Oo - I/O7; the 16 bits of data appear on I/Oo~I/O15. The is offered in 48-ball FBGA and 48-Pin TSOP packages. This device is designed to be programmed in-system with the standard system 5.0 volt VCC supply. Additional 12.0 volt VPP is not required for in-system write or erase operations. However, the A29160A can also be programmed in standard EPROM programmers. The A29160A has the first toggle bit, I/O6, which indicates whether an Embedded Program or Erase is in progress, or it is in the Erase Suspend. Besides the I/O6 toggle bit, the A29160A has a second toggle bit, I/O2, to indicate whether the addressed sector is being selected for erase. The A29160A also offers the ability to program in the Erase Suspend mode. The standard A29160A offers access times of 55 and 70, allowing high-speed microprocessors to operate without wait states. To eliminate bus contention the

device has separate chip enable ( $\overline{\text{CE}}$ ), write enable ( $\overline{\text{WE}}$ ) and output enable ( $\overline{\text{OE}}$ ) controls.

The device requires only a single 5.0 volt power supply for both read and write functions. Internally generated and regulated voltages are provided for the program and erase operations.

The A29160A is entirely software command set compatible with the JEDEC single-power-supply Flash standard. Commands are written to the command register using standard microprocessor write timings. Register contents serve as input to an internal state-machine that controls the erase and programming circuitry. Write cycles also internally latch addresses and data needed for the programming and erase operations. Reading data out of the device is similar to reading from other Flash or EPROM devices.

Device programming occurs by writing the proper program command sequence. This initiates the Embedded Program



algorithm - an internal algorithm that automatically times the program pulse widths and verifies proper program margin.

Device erasure occurs by executing the proper erase command sequence. This initiates the Embedded Erase algorithm - an internal algorithm that automatically preprograms the array (if it is not already programmed) before executing the erase operation. During erase, the device automatically times the erase pulse widths and verifies proper erase margin. The Unlock Bypass mode facilitates faster programming times by requiring only two write cycles to program data instead of four.

The host system can detect whether a program or erase operation is complete by observing the RY /  $\overline{BY}$  pin, or by reading the I/Or ( $\overline{Data}$  Polling) and I/O<sub>6</sub> (toggle) status bits. After a program or erase cycle has been completed, the device is ready to read array data or accept another command.

The sector erase architecture allows memory sectors to be erased and reprogrammed without affecting the data contents of other sectors. The A29160A is fully erased when shipped from the factory.

The hardware sector protection feature disables operations for both program and erase in any combination of the sectors of memory. This can be achieved via programming equipment.

The Write Protect ( $\overline{\text{WP}}$ ) features protects the 16 Kbyte boot sector from erasure by asserting a logic low on the  $\overline{\text{WP}}$  pin, whether or not the sector had been previously protected.

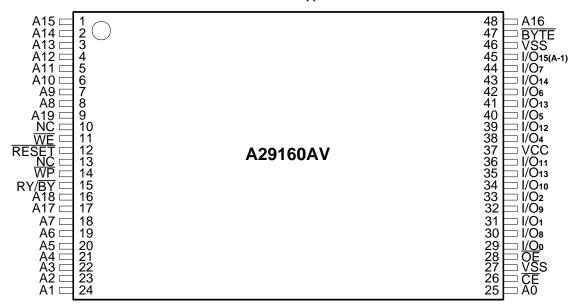
The Erase Suspend/Erase Resume feature enables the user to put erase on hold for any period of time to read data from, or program data to, any other sector that is not selected for erasure. True background erase can thus be achieved.

The hardware RESET pin terminates any operation in progress and resets the internal state machine to reading array data. The RESET pin may be tied to the system reset circuitry. A system reset would thus also reset the device, enabling the system microprocessor to read the boot-up firmware from the Flash memory.

The device offers power-saving features. The system can place the device into the standby mode. Power consumption is greatly reduced in the standby modes.

#### **Pin Configurations**

### ■ TSOP (I)





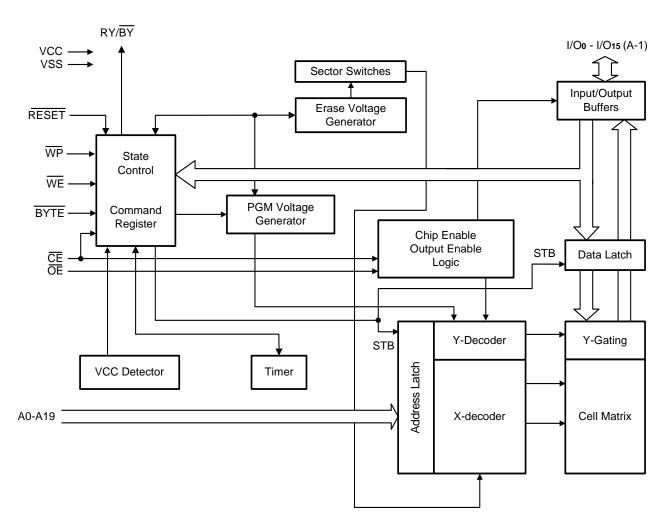
# **Pin Configurations (continued)**

# ■ TFBGA

	TFBGA Top View, Balls Facing Down									
(A6	) (B6)	C6	D6	E6	F6	G6	(H6)			
A13	A12	A14	A15	A16	BYTE	I/O <sub>15</sub> (A-	1) VSS			
(A5 A9	) (B5)	C5 A10	D5)	E5 I/O 7	F5 I/O <sub>14</sub>	G5 I/O <sub>13</sub>	H5)			
(A4) WE	B4 RESET	C4	D4) A19	E4 I/O 5	F4)	G4 VCC	H4)			
A3	B3	C3	D3	E3	F3	G3	H3)			
RY/B	WP	A18	NC	I/O <sub>2</sub>	I/O <sub>10</sub>	I/O <sub>11</sub>	I/O <sub>3</sub>			
A2	) B2	C2	D2	E2	F2	G2	H2			
A7	A17	A6	A5	I/O <sub>0</sub>	I/O <sub>8</sub>	I/O <sub>9</sub>	I/O <sub>1</sub>			
A1	) <u>B1</u>	C1	D1	E1	F1	G1	H1)			
A3	A4	A2	A1	A0	CE	OE	VSS			
•										



# **Block Diagram**



# **Pin Descriptions**

Pin	No.	Description
A0 -	A19	Address Inputs
I/O <sub>0</sub> -	· I/O14	Data Inputs/Outputs
	I/O <sub>15</sub>	Data Input/Output, Word Mode
I/O <sub>15</sub> (A <sub>-1</sub> )	A <sub>-1</sub>	LSB Address Input, Byte Mode
Ō	ΞE	Chip Enable
M	/E	Write Enable
V	/P	Write Protection
Ō	ÞΕ	Output Enable
RE	SET	Hardware Reset
BY	ΤE	Selects Byte Mode or Word Mode
RY	'BY	Ready/BUSY - Output
V	SS	Ground
V	CC	Power Supply
N	IC	Pin not connected internally



#### **Absolute Maximum Ratings\***

#### Notes:

- Minimum DC voltage on input or I/O pins is -0.5V. During voltage transitions, input or I/O pins may undershoot VSS to -2.0V for periods of up to 20ns. Maximum DC voltage on input and I/O pins is VCC +0.5V. During voltage transitions, input or I/O pins may overshoot to VCC +2.0V for periods up to 20ns.
- Minimum DC input voltage on A9, OE and RESET is

   0.5V. During voltage transitions, A9, OE and RESET may overshoot VSS to -2.0V for periods of up to 20ns. Maximum DC input voltage on A9 is +11.5V which may overshoot to 13.5V for periods up to 20ns.
- 3. No more than one output is shorted at a time. Duration of the short circuit should not be greater than one second.

# \*Comments

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to this device. These are stress ratings only. Functional operation of this device at these or any other conditions above those indicated in the operational sections of these specification is not implied or intended. Exposure to the absolute maximum rating conditions for extended periods may affect device reliability.

#### **Operating Ranges**

#### Commercial (C) Devices

Ambient Temperature (T<sub>A</sub>) . . . . . . . . . . 0°C to +70°C

#### Industrial (I) Devices

Ambient Temperature (T<sub>A</sub>) . . . . . . . . . . -40°C to +85°C

#### **VCC Supply Voltages**

VCC for all devices ......+4.5V to +5.5V Operating ranges define those limits between which the functionally of the device is guaranteed.

#### **Device Bus Operations**

This section describes the requirements and use of the device bus operations, which are initiated through the internal command register. The command register itself does not occupy any addressable memory location. The register is composed of latches that store the commands, along with the address and data information needed to execute the

command. The contents of the register serve as inputs to the internal state machine. The state machine outputs dictate the function of the device. The appropriate device bus operations table lists the inputs and control levels required, and the resulting output. The following subsections describe each of these operations in further detail.

Table 1. A29160A Device Bus Operations

Operation	CE	OE	WE	WP	RESET	A0 – A19	I/O <sub>0</sub> - I/O <sub>7</sub>	I/O	8 <b>- I/O</b> 15
						(Note 1)		BYTE =VIH	BYTE =V⊩
Read	L	L	Н	Х	Н	Ain	Douт	Douт	I/O <sub>8</sub> ~I/O <sub>14</sub> =High-Z I/O <sub>15</sub> =A-1
Write	L	Н	L	See	Н	Ain	Din	Din	I/O8~I/O14=High-Z
				Note 3					I/O15=A-1
CMOS Standby	VCC ± 0.3 V	Х	Х	See Note 4	VCC ± 0.3 V	Х	High-Z	High-Z	High-Z
Output Disable	L	Н	Н	Х	Н	X	High-Z	High-Z	High-Z
Hardware Reset	Х	Χ	Χ	Х	L	X	High-Z	High-Z	High-Z
Sector Protect (See Note 2)	L	Н	L	Х	Vid	Sector Address, A6=L, A1=H, A0=L	Din	Х	Х
Sector Unprotect (See Note 2)	L	Н	L	Х	Vid	Sector Address, A6=H, A1=H, A0=L	Din	Х	Х
Temporary Sector Unprotect	Х	Х	Х	See Note 3	Vid	Ain	Din	Din	Х

#### Legend:

L = Logic Low = V<sub>IL</sub>, H = Logic High = V<sub>IH</sub>, V<sub>ID</sub> = 10.5 ± 1.0V, X = Don't Care, D<sub>IN</sub> = Data In, Douτ = Data Out, A<sub>IN</sub> = Address In

- 1. Addresses are A19:A0 in word mode ( $\overline{BYTE} = V_{H}$ ), A19: A<sub>-1</sub> in byte mode ( $\overline{BYTE} = V_{L}$ ).
- 2. See the "Sector Protection/Unprotection" section and Temporary Sector Unprotect for more information.
- 3. The 16Kbyte boot sector is protected from erasure when  $WP = V_{\perp}$
- 4. In CMOS mode, WP must be at VCC or left floating.



### **Word/Byte Configuration**

The BYTE pin determines whether the I/O pins I/O<sub>15</sub>-I/O<sub>0</sub> operate in the byte or word configuration. If the  $\overline{\text{BYTE}}$  pin is set at logic "1", the device is in word configuration, I/O<sub>15</sub>-I/O<sub>0</sub> are active and controlled by  $\overline{\text{CE}}$  and  $\overline{\text{OE}}$ .

If the  $\overline{\text{BYTE}}$  pin is set at logic "0", the device is in byte configuration, and only I/O<sub>0</sub>-I/O<sub>7</sub> are active and controlled by  $\overline{\text{CE}}$  and  $\overline{\text{OE}}$ . I/O<sub>8</sub>-I/O<sub>14</sub> are tri-stated, and I/O<sub>15</sub> pin is used as an input for the LSB(A-1) address function.

#### **Requirements for Reading Array Data**

To read array data from the outputs, the system must drive the  $\overline{CE}$  and  $\overline{OE}$  pins to Vil.  $\overline{CE}$  is the power control and selects the device.  $\overline{OE}$  is the output control and gates array data to the output pins.  $\overline{WE}$  should remain at Vih all the time during read operation. The  $\overline{BYTE}$  pin determines whether the device outputs array data in words and bytes. The internal state machine is set for reading array data upon device power-up, or after a hardware reset. This ensures that no spurious alteration of the memory content occurs during the power transition. No command is necessary in this mode to obtain array data. Standard microprocessor read cycles that assert valid addresses on the device address inputs produce valid data on the device data outputs. The device remains enabled for read access until the command register contents are altered.

See "Reading Array Data" for more information. Refer to the AC Read Operations table for timing specifications and to the Read Operations Timings diagram for the timing waveforms, lcc1 in the DC Characteristics table represents the active current specification for reading array data.

#### **Writing Commands/Command Sequences**

To write a command or command sequence (which includes programming data to the device and erasing sectors of memory), the system must drive  $\overline{WE}$  and  $\overline{CE}$  to  $V_{IL}$ , and  $\overline{OE}$  to  $V_{IH}$ . For program operations, the  $\overline{BYTE}$  pin determines whether the device accepts program data in bytes or words, Refer to "Word/Byte Configuration" for more information. The device features an Unlock Bypass mode to facilitate faster programming. Once the device enters the Unlock Bypass mode, only two write cycles are required to program a word or byte, instead of four.

The "Word / Byte Program Command Sequence" section has details on programming data to the device using both standard and Unlock Bypass command sequence. An erase operation can erase one sector, multiple sectors, or the entire device. The Sector Address Tables indicate the address range that each sector occupies. A "sector address" consists of the address inputs required to uniquely select a sector. See the "Command Definitions" section for details on erasing a sector or the entire chip, or suspending/resuming the erase operation.

After the system writes the autoselect command sequence, the device enters the autoselect mode. The system can then read autoselect codes from the internal register (which is separate from the memory array) on I/O7 - I/O0. Standard read cycle timings apply in this mode. Refer to the "Autoselect Mode" and "Autoselect Command Sequence" sections for more information.

lcc2 in the DC Characteristics table represents the active current specification for the write mode. The "AC

Characteristics" section contains timing specification tables and timing diagrams for write operations.

#### **Program and Erase Operation Status**

During an erase or program operation, the system may check the status of the operation by reading the status bits on I/O<sub>7</sub> - I/O<sub>0</sub>. Standard read cycle timings and Icc read specifications apply. Refer to "Write Operation Status" for more information, and to each AC Characteristics section for timing diagrams.

#### Standby Mode

When the system is not reading or writing to the device, it can place the device in the standby mode. In this mode, current consumption is greatly reduced, and the outputs are placed in the high impedance state, independent of the  $\overline{\text{OE}}$  input.

The device enters the CMOS standby mode when the CE &  $\overline{\text{RESET}}$  pins are both held at VCC  $\pm$  0.5V. (Note that this is a more restricted voltage range than Vih.) If  $\overline{\text{CE}}$  and  $\overline{\text{RESET}}$  are held at Vih, but not within VCC  $\pm$  0.5V, the device will be in the standby mode, but the standby current will be greater. The device requires the standard access time (tce) before it is ready to read data.

If the device is deselected during erasure or programming, the device draws active current until the operation is completed.

Icc3 and Icc4 in the DC Characteristics tables represent the standby current specification.

#### **Output Disable Mode**

When the OE input is at VIH, output from the device is disabled. The output pins are placed in the high impedance state.

#### **RESET**: Hardware Reset Pin

The RESET pin provides a hardware method of resetting the device to reading array data. When the system drives the  $\overline{\text{RESET}}$  pin low for at least a period of trp, the device immediately terminates any operation in progress, tristates all data output pins, and ignores all read/write attempts for the duration of the  $\overline{\text{RESET}}$  pulse. The device also resets the internal state machine to reading array data. The operation that was interrupted should be reinitiated once the device is ready to accept another command sequence, to ensure data integrity.

Current is reduced for the duration of the RESET pulse. When RESET is held at VSS  $\pm$  0.5V, the device draws CMOS standby current (Icc4). If RESET is held at V<sub>IL</sub> but not within VSS  $\pm$  0.5V, the standby current will be greater.

The RESET pin may be tied to the system reset circuitry. A system reset would thus also reset the Flash memory, enabling the system to read the boot-up firmware from the Flash memory.

If RESET is asserted during a program or erase operation, the RY/BY pin remains a "0" (busy) until the internal reset operation is complete, which requires a time tready (during Embedded Algorithms). The system can thus monitor RY/BY to determine whether the reset operation is complete. If RESET is asserted when a program or erase operation is not executing (RY/BY pin is "1"), the reset operation is completed within a time of tready (not during



 $\mbox{Embedded}$  Algorithms). The system can read data tRH after the  $\overline{\mbox{RESET}}$  pin return to VIH.

Refer to the AC Characteristics tables for  $\overline{\text{RESET}}$  parameters and diagram.

Table 2. A29160A Top Boot Block Sector Address Table

Sector	A19	A18	A17	A16	A15	A14	A13	A12	Sector Size	Address Range	(in hexadecimal)
									(Kbytes/ Kwords)	Byte Mode (x8)	Word Mode (x16)
SA0	0	0	0	0	0	X	Χ	Χ	64/32	000000 - 00FFFF	00000 - 07FFF
SA1	0	0	0	0	1	Х	Χ	Χ	64/32	010000 - 01FFFF	08000 - 0FFFF
SA2	0	0	0	1	0	Х	Χ	Χ	64/32	020000 - 02FFFF	10000 - 17FFF
SA3	0	0	0	1	1	Х	Χ	Χ	64/32	030000 - 03FFFF	18000 - 1FFFF
SA4	0	0	1	0	0	X	Χ	Χ	64/32	040000 - 04FFFF	20000 - 27FFF
SA5	0	0	1	0	1	X	Χ	Χ	64/32	050000 - 05FFFF	28000 - 2FFFF
SA6	0	0	1	1	0	X	Χ	Χ	64/32	060000 - 06FFFF	30000 - 37FFF
SA7	0	0	1	1	1	Х	Х	Χ	64/32	070000 - 07FFFF	38000 - 3FFFF
SA8	0	1	0	0	0	Х	Χ	Χ	64/32	080000 - 08FFFF	40000 - 47FFF
SA9	0	1	0	0	1	X	Χ	Χ	64/32	090000 - 09FFFF	48000 - 4FFFF
SA10	0	1	0	1	0	Х	Χ	Χ	64/32	0A0000 - 0AFFFF	50000 - 57FFF
SA11	0	1	0	1	1	X	Χ	Χ	64/32	0B0000 - 0BFFFF	58000 - 5FFFF
SA12	0	1	1	0	0	Χ	Χ	Χ	64/32	0C0000 - 0CFFFF	60000 - 67FFF
SA13	0	1	1	0	1	Х	Χ	Χ	64/32	0D0000 - 0DFFFF	68000 - 6FFFF
SA14	0	1	1	1	0	Х	Χ	Χ	64/32	0E0000 - 0EFFFF	70000 - 77FFF
SA15	0	1	1	1	1	Х	Χ	Χ	64/32	0F0000 - 0FFFFF	78000 - 7FFFF
SA16	1	0	0	0	0	X	Χ	Χ	64/32	100000 - 10FFFF	80000 - 87FFF
SA17	1	0	0	0	1	X	Χ	Χ	64/32	110000 - 11FFFF	88000 - 8FFFF
SA18	1	0	0	1	0	X	Χ	Χ	64/32	120000 - 12FFFF	90000 - 97FFF
SA19	1	0	0	1	1	X	Χ	Χ	64/32	130000 - 13FFFF	98000 - 9FFFF
SA20	1	0	1	0	0	Χ	Χ	Χ	64/32	140000 - 14FFFF	A0000 - A7FFF
SA21	1	0	1	0	1	Х	Χ	Χ	64/32	150000 - 15FFFF	A8000 - AFFFF
SA22	1	0	1	1	0	X	Χ	Χ	64/32	160000 - 16FFFF	B0000 - B7FFF
SA23	1	0	1	1	1	X	Χ	Χ	64/32	170000 - 17FFFF	B8000 - BFFFF
SA24	1	1	0	0	0	X	Χ	Χ	64/32	180000 - 18FFFF	C0000 - C7FFF
SA25	1	1	0	0	1	Х	Χ	Χ	64/32	190000 - 19FFFF	C8000 - CFFFF
SA26	1	1	0	1	0	Х	Χ	Χ	64/32	1A0000 - 1AFFFF	D0000 - D7FFF
SA27	1	1	0	1	1	X	Χ	Χ	64/32	1B0000 - 1BFFFF	D8000 - DFFFF
SA28	1	1	1	0	0	Χ	Χ	Χ	64/32	1C0000 - 1CFFFF	E0000 - E7FFF
SA29	1	1	1	0	1	Х	Х	Χ	64/32	1D0000 - 1DFFFF	E8000 - EFFFF
SA30	1	1	1	1	0	Х	Х	Х	64/32	1E0000 - 1EFFFF	F0000 - F7FFF
SA31	1	1	1	1	1	0	Х	Х	32/16	1F0000 - 1F7FFF	F8000 - FBFFF
SA32	1	1	1	1	1	1	0	0	8/4	1F8000 - 1F9FFF	FC000 - FCFFF
SA33	1	1	1	1	1	1	0	1	8/4	1FA000 - 1FBFFF	FD000 - FDFFF
SA34	1	1	1	1	1	1	1	Х	16/8	1FC000 - 1FFFFF	FE000 - FFFFF

Note:

 $Address\ range\ is\ A19: A_{-1}\ in\ byte\ mode\ and\ A19: A0\ in\ word\ mode.\ See\ "Word/Byte\ Configuration"\ section.$ 



Table 3. A29160A Bottom Boot Block Sector Address Table

Sector	A19	A18	A17	A16	A15	A14	A13	A12	Sector Size	Address Range	(in hexadecimal)
									(Kbytes/ Kwords)	Byte Mode (x8)	Word Mode (x16)
SA0	0	0	0	0	0	0	0	Х	16/8	000000 - 003FFF	00000 - 01FFF
SA1	0	0	0	0	0	0	1	0	8/4	004000 - 005FFF	02000 - 02FFF
SA2	0	0	0	0	0	0	1	1	8/4	006000 - 007FFF	03000 - 03FFF
SA3	0	0	0	0	0	1	Х	Х	32/16	008000 - 00FFFF	04000 - 07FFF
SA4	0	0	0	0	1	Х	Х	Х	64/32	010000 - 01FFFF	08000 - 0FFFF
SA5	0	0	0	1	0	Х	Х	Х	64/32	020000 - 02FFFF	10000 - 17FFF
SA6	0	0	0	1	1	Х	Х	Х	64/32	030000 - 03FFFF	18000 - 1FFFF
SA7	0	0	1	0	0	Х	Х	Х	64/32	040000 - 04FFFF	20000 - 27FFF
SA8	0	0	1	0	1	Х	Х	Х	64/32	050000 - 05FFFF	28000 - 2FFFF
SA9	0	0	1	1	0	Х	Х	Х	64/32	060000 - 06FFFF	30000 - 37FFF
SA10	0	0	1	1	1	Х	Х	Х	64/32	070000 - 07FFFF	38000 - 3FFFF
SA11	0	1	0	0	0	Х	Х	Х	64/32	080000 - 08FFFF	40000 - 47FFF
SA12	0	1	0	0	1	Х	Х	Х	64/32	090000 - 09FFFF	48000 - 4FFFF
SA13	0	1	0	1	0	Х	Х	Х	64/32	0A0000 - 0AFFFF	50000 - 57FFF
SA14	0	1	0	1	1	Х	Х	Х	64/32	0B0000 - 0BFFFF	58000 - 5FFFF
SA15	0	1	1	0	0	Х	Х	Х	64/32	0C0000 - 0CFFFF	60000 - 67FFF
SA16	0	1	1	0	1	Х	Х	Х	64/32	0D0000 - 0DFFFF	68000 - 6FFFF
SA17	0	1	1	1	0	Х	Х	Х	64/32	0E0000 - 0EFFFF	70000 - 77FFF
SA18	0	1	1	1	1	Х	Х	Х	64/32	0F0000 - 0FFFFF	78000 - 7FFFF
SA19	1	0	0	0	0	Х	Х	Х	64/32	100000 - 10FFFF	80000 - 87FFF
SA20	1	0	0	0	1	Х	Х	Х	64/32	110000 - 11FFFF	88000 - 8FFFF
SA21	1	0	0	1	0	Х	Х	Х	64/32	120000 - 12FFFF	90000 - 97FFF
SA22	1	0	0	1	1	Х	Х	Х	64/32	130000 - 13FFFF	98000 - 9FFFF
SA23	1	0	1	0	0	Х	Х	Х	64/32	140000 - 14FFFF	A0000 - A7FFF
SA24	1	0	1	0	1	Х	Х	Х	64/32	150000 - 15FFFF	A8000 - AFFFF
SA25	1	0	1	1	0	Х	Х	Х	64/32	160000 - 16FFFF	B0000 – B7FFF
SA26	1	0	1	1	1	Х	Х	Х	64/32	170000 - 17FFFF	B8000 - BFFFF
SA27	1	1	0	0	0	Х	Х	Х	64/32	180000 - 18FFFF	C0000 - C7FFF
SA28	1	1	0	0	1	Х	Х	Х	64/32	190000 - 19FFFF	C8000 - CFFFF
SA29	1	1	0	1	0	Х	Х	Х	64/32	1A0000 - 1AFFFF	D0000 - D7FFF
SA30	1	1	0	1	1	Х	Х	Х	64/32	1B0000 - 1BFFFF	D8000 - DFFFF
SA31	1	1	1	0	0	Х	Х	Х	64/32	1C0000 - 1CFFFF	E0000 - E7FFF
SA32	1	1	1	0	1	Х	Х	Х	64/32	1D0000 - 1DFFFF	E8000 - EFFFF
SA33	1	1	1	1	0	Х	Х	Х	64/32	1E0000 - 1EFFFF	F0000 - F7FFF
SA34	1	1	1	1	1	Х	Х	Х	64/32	1F0000 - 1FFFFF	F8000 - FFFFF

Note:

Address range is A19 : A-1 in byte mode and A19 : A0 in word mode. See "Word/Byte Configuration" section.



#### **Autoselect Mode**

The autoselect mode provides manufacturer and device identification, and sector protection verification, through identifier codes output on I/O7 - I/O0. This mode is primarily intended for programming equipment to automatically match a device to be programmed with its corresponding programming algorithm. However, the autoselect codes can also be accessed in-system through the command register. When using programming equipment, the autoselect mode requires VID (9.5V to 11.5 V) on address pin A9. Address pins A6, A1, and A0 must be as shown in Autoselect Codes (High Voltage Method) table. In addition, when verifying sector protection, the sector address must appear on the

appropriate highest order address bits. Refer to the corresponding Sector Address Tables. The Command Definitions table shows the remaining address bits that are don't care. When all necessary bits have been set as required, the programming equipment may then read the corresponding identifier code on I/O7 - I/O0.To access the autoselect codes in-system, the host system can issue the autoselect command via the command register, as shown in the Command Definitions table. This method does not require VID. See "Command Definitions" for details on using the autoselect mode.

Table 4. A29160A Autoselect Codes (High Voltage Method)

Description	Mode	CE	OE	WE	A19 to A12	A11 to A10	А9	A8 to A7	A6	A5 to A2	A1	A0	I/O8 to I/O15	I/O <sub>7</sub> to I/O <sub>0</sub>
Manufacturer ID: AMIC		L	L	Н	Х	Х	Vid	Х	L	Х	L	L	Х	37h
Device ID: A29160A	Word												22h	D2h
(Top Boot Block)	Byte	L	L	Н	Х	Х	Vid	Х	L	Х	L	Н	Х	D2h
Device ID: A29160A	Word												22h	D8h
(Bottom Boot Block)	Byte	L	L	Н	Х	Х	Vid	Х	L	Х	L	Н	Х	D8h
Continuation ID		L	L	Н	Х	Х	Vid	Х	L	Х	Н	Н	Х	7Fh
Sector Protection Verification		L	L	Н	SA	Х	Vid	X	L	Х	Н	L	Х	01h (protected)
Occion i rotection veni	noation	_	ı	11	OA	Χ	VID	, ,	_	,		ı	X	00h (unprotected)

L=Logic Low= V<sub>IL</sub>, H=Logic High=V<sub>IH</sub>, SA=Sector Address, X=Don't Care.

Note: The autoselect codes may also be accessed in-system via command sequences.



#### **Sector Protection/Unprotection**

The hardware sector protection feature disables both program and erase operations in any sector. The hardware sector unprotection feature re-enables both program and erase operations in previously protected sectors.

It is possible to determine whether a sector is protected or unprotected. See "Autoselect Mode" for details.

Sector protection / unprotection can be implemented via two methods. The primary method requires VID on the RESET pin only, and can be implemented either in-system or via programming equipment. Figure 2 shows the algorithm and the Sector Protect / Unprotect Timing Diagram illustrates the timing waveforms for this feature. This method uses standard microprocessor bus cycle timing. For sector unprotect, all unprotected sectors must first be protected prior to the first sector unprotect write cycle. The alternate method must be implemented using programming equipment. The procedure requires a high voltage (VID) on address pin A9 and the control pins.

The device is shipped with all sectors unprotected.

It is possible to determine whether a sector is protected or unprotected. See "Autoselect Mode" for details.

#### **Hardware Data Protection**

The requirement of command unlocking sequence for programming or erasing provides data protection against inadvertent writes (refer to the Command Definitions table). In addition, the following hardware data protection measures prevent accidental erasure or programming, which might otherwise be caused by spurious system level signals during Vcc power-up transitions, or from system noise. The device is powered up to read array data to avoid accidentally writing data to the array.

#### Write Protect (WP)

The Write Protect function provides a hardware method of protecting the 16Kbytes of boot sector from erasure without using  $V_{\text{ID}}$ .

If the system asserts VIL on the  $\overline{WP}$  pin, the device disables erase function for the 16Kbyte boot sector (SA34 for the top boot device and SA0 for the bottom boot device) independently of whether those sectors were protected or unprotected using the method described in Sector Protection/Unprotection.

If the system asserts VIH on the  $\overline{WP}$  pin, the device reverts to whether the 16Kbyte boot sector was previously set to protect or unprotected using the method described in Sector Protection/Unprotection.

#### Low VCC Write Inhibit

When VCC is lower than  $V_{LKO}$ , the device does not accept any write cycles. This protects data during VCC power up and power down. The command register and all internal program/erase circuits are disabled, and the device resets. Subsequent writes are ignored until VCC is greater than  $V_{LKO}$ . The system must provide the proper signals to the control pins to prevent unintentional writes when VCC is greater than  $V_{LKO}$ .

#### Write Pulse "Glitch" Protection

Noise pulses of less than 5ns (typical) on  $\overline{OE}$ ,  $\overline{CE}$  or  $\overline{WE}$  do not initiate a write cycle.

#### Logical Inhibit

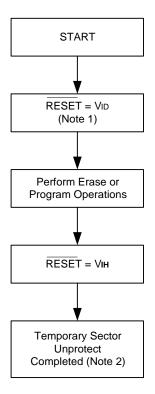
Write cycles are inhibited by holding any one of  $\overline{OE}$  =V<sub>I</sub>L,  $\overline{CE}$  = V<sub>I</sub>H or  $\overline{WE}$  = V<sub>I</sub>H. To initiate a write cycle,  $\overline{CE}$  and  $\overline{WE}$  must be a logical zero while  $\overline{OE}$  is a logical one.

#### **Power-Up Write Inhibit**

If  $\overline{WE} = \overline{CE} = V_{IL}$  and  $\overline{OE} = V_{IH}$  during power up, the device does not accept commands on the rising edge of  $\overline{WE}$ . The internal state machine is automatically reset to reading array data on the initial power-up.

#### **Temporary Sector Unprotect**

This feature allows temporary unprotection of previous protected sectors to change data in-system. The Sector Unprotect mode is activated by setting the RESET pin to Vid. During this mode, formerly protected sectors can be programmed or erased by selecting the sector addresses. Once Vid is removed from the RESET pin, all the previously protected sectors are protected again. Figure 1 shows the algorithm, and the Temporary Sector Unprotect diagram shows the timing waveforms, for this feature.



- All protected sectors unprotected.
- 2. All previously protected sectors are protected once again.

Figure 1. Temporary Sector Unprotect Operation



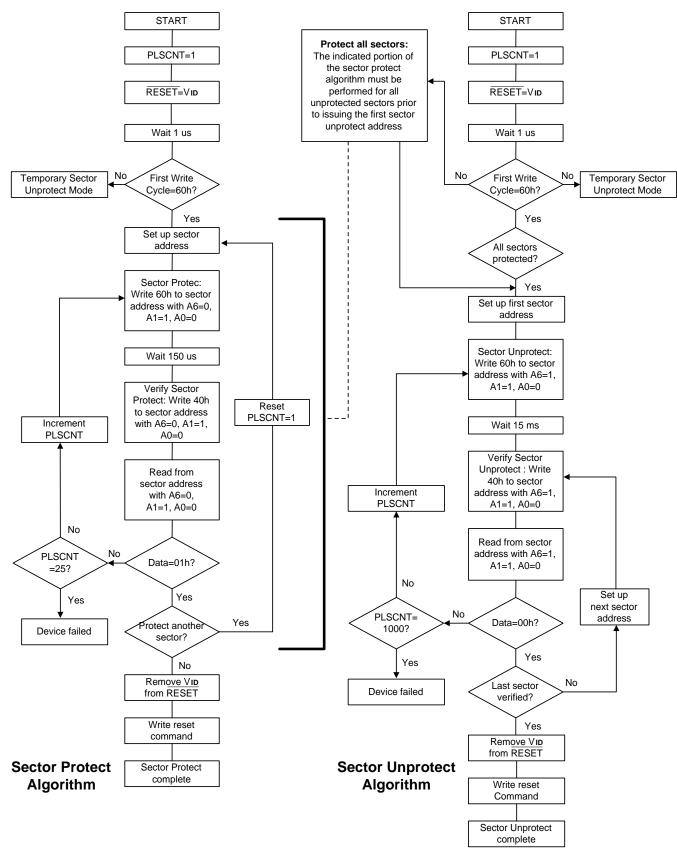


Figure 2. In-System Sector Protect/Unprotect Algorithms



#### **Common Flash Memory Interface (CFI)**

The Common Flash Interface (CFI) specification outlines device and host system software interrogation handshake, which allows specific vendor-specified software algorithms to be used for entire families of devices. Software support can then be device-independent, JEDEC ID-independent, and forward- and backward-compatible for the specified flash device families. Flash vendors can standardize their existing interface for long-term compatibility.

This device enters the CFI Query mode when the system writes the CFI Query command, 98h, to address 55h in word mode (or address AAh in byte mode), any time the device is

ready to read array data. The system can read CFI information at the addresses given in Table 5-8. In word mode, the upper address bits (A7-MSB) must be all zeros. To terminate reading CFI data, the system must write the reset command.

The system can also write the CFI query command when the device is in the autoselect mode. The device enters the CFI query mode, and the system can read CFI data at the addresses given in Table 5-8. The system must write the reset command to return the device to the autoselect mode.

**Table 5. CFI Query Identification String** 

Addresses (Word Mode)	Addresses (Byte Mode)	Data	Description
10h	20h	0051h	
11h	22h	0052h	Query Unique ASCII string "QRY"
12h	24h	0059h	
13h	26h	0002h	Drimary OFM Command Sat
14h	28h	0000h	Primary OEM Command Set
15h	2Ah	0040h	Address for Drimany Extended Table
16h	2Ch	0000h	Address for Primary Extended Table
17h	2Eh	0000h	Alternate OFM Command Set (OOb _ none oviete)
18h	30h	0000h	Alternate OEM Command Set (00h = none exists)
19h	32h	0000h	Address for Alternate OFM Extended Table (00b page exists)
1Ah	34h	0000h	Address for Alternate OEM Extended Table (00h = none exists)

**Table 6. System Interface String** 

Addresses (Word Mode)	Addresses (Byte Mode)	Data	Description
1Bh	36h	0045h	VCC Min. (write/erase)
			VO <sub>7</sub> - VO₄: volt, I/O₃- VO∷ 100 millivolt
1Ch	38h	0055h	VCC Max. (write/erase)
			VO <sub>7</sub> - VO₄: volt, I/O₃- VOα: 100 millivolt
1Dh	3Ah	0000h	Vpp Min. voltage (00h = no Vpp pin present)
1Eh	3Ch	0000h	Vpp Max. voltage (00h = no Vpp pin present)
1Fh	3Eh	0004h	Typical timeout per single byte/word write 2 <sup>N</sup> μs
20h	40h	0000h	Typical timeout for Min. size buffer write 2 <sup>N</sup> μs (00h = not supported)
21h	42h	000Ah	Typical timeout per individual block erase 2 <sup>N</sup> ms
22h	44h	0000h	Typical timeout for full chip erase 2 <sup>N</sup> ms (00h = not supported)
23h	46h	0005h	Max. timeout for byte/word write 2 <sup>N</sup> times typical
24h	48h	0000h	Max. timeout for buffer write 2 <sup>N</sup> times typical
25h	4Ah	0004h	Max. timeout per individual block erase 2 <sup>N</sup> times typical
26h	4Ch	0000h	Max. timeout for full chip erase 2 <sup>N</sup> times typical (00h = not supported)



**Table 7. Device Geometry Definition** 

Addresses (Word Mode)	Addresses (Byte Mode)	Data	Description	
27h	4Eh	0015h	Device Size = 2 <sup>N</sup> byte	
28h	50h	0002h	501100 0120 = 2 8510	
29h	52h	0002h	Flash Device Interface Description	
2Ah	54h	0000h	Max. number of byte in multi-byte write = 2 <sup>N</sup>	
2Bh	56h	0000h	(00h = not supported)	
2Ch	58h	0004h	Number of Erase Block Regions within device	
2Dh	5Ah	0000h		
2Eh	5Ch	0000h	Erase Block Region 1 Information	
2Fh	5Eh	0040h	(refer to the CFI specification)	
30h	60h	0000h		
31h	62h	0001h		
32h	64h	0000h	France Block Basins & Information	
33h	66h	0020h	Erase Block Region 2 Information	
34h	68h	0000h		
35h	6Ah	0000h		
36h	6Ch	0000h	Erase Block Region 3 Information	
37h	6Eh	0080h	Erase block Region 3 information	
38h	40h	0000h		
39h	72h	001Eh		
3Ah	74h	0000h	Erase Block Region 4 Information	
3ВН	76h	0000h	Liase block Region 4 initimation	
3Ch	78h	0001h		



Table 8. Primary Vendor-Specific Extended Query

Addresses (Word Mode)	Addresses (Byte Mode)	Data	Description
40h	80h	0050h	
41h	82h	0052h	Query-unique ASCII string "PRI"
42h	84h	0049h	
43h	86h	0031h	Major version number, ASCII
44h	88h	0031h	Minor version number, ASCII
45h	8Ah	0000h	Address Sensitive Unlock
			0 = Required, 1 = Not Required
46h	8Ch	0002h	Erase Suspend
			0 = Not Supported, 1 = To Read Only, 2 = To Read & Write
47h	8Eh	0001h	Sector Protect
			0 = Not Supported, X = Number of sectors in per group
48h	90h	0001h	Sector Temporary Unprotect
			00 = Not Supported, 01 = Supported
49h	92h	0004h	Sector Protect/Unprotect scheme
			01 = 29F040 mode, 02 = 29F016 mode,
			03 = 29F400 mode, 04 = 29L160 mode
4Ah	94h	0000h	Simultaneous Operation
			00 = Not Supported, 01 = Supported
48h	96h	0000h	Burst Mode Type
			00 = Not Supported, 01 = Supported
4Ch	98h	0000h	Page Mode Type
			00 = Not Supported, 01 = 4 Word Page, 02 = 8 Word Page
4Dh	9Ah	00h	ACC Supply Minimum
4Eh	9Ch	00h	ACC Supply Maximum
456	02h		Top/Bottom Boot Sector Flag
4Fh	9Eh	03h	2 = Bottom, 3 = Top



#### **Command Definitions**

Writing specific address and data commands or sequences into the command register initiates device operations. The Command Definitions table defines the valid register command sequences. Writing incorrect address and data values or writing them in the improper sequence resets the device to reading array data.

All addresses are latched on the falling edge of  $\overline{\text{VE}}$  or  $\overline{\text{CE}}$ , whichever happens later. All data is latched on the rising edge of  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$ , whichever happens first. Refer to the appropriate timing diagrams in the "AC Characteristics" section.

#### **Reading Array Data**

The device is automatically set to reading array data after device power-up. No commands are required to retrieve data. The device is also ready to read array data after completing an Embedded Program or Embedded Erase algorithm. After the device accepts an Erase Suspend command, the device enters the Erase Suspend mode. The system can read array data using the standard read timings, except that if it reads at an address within erase-suspended sectors, the device outputs status data. After completing a programming operation in the Erase Suspend mode, the system may once again read array data with the same exception. See "Erase Suspend/Erase Resume Commands" for more information on this mode.

The system must issue the reset command to re-enable the device for reading array data if I/Os goes high, or while in the autoselect mode. See the "Reset Command" section, next. See also "Requirements for Reading Array Data" in the "Device Bus Operations" section for more information. The Read Operations table provides the read parameters, and Read Operation Timings diagram shows the timing diagram.

#### **Reset Command**

Writing the reset command to the device resets the device to reading array data. Address bits are don't care for this command. The reset command may be written between the sequence cycles in an erase command sequence before erasing begins. This resets the device to reading array data. Once erasure begins, however, the device ignores reset commands until the operation is complete.

The reset command may be written between the sequence cycles in a program command sequence before programming begins. This resets the device to reading array data (also applies to programming in Erase Suspend mode). Once programming begins, however, the device ignores reset commands until the operation is complete.

The reset command may be written between the sequence cycles in an autoselect command sequence. Once in the autoselect mode, the reset command must be written to return to reading array data (also applies to autoselect during Erase Suspend).

If I/O<sub>5</sub> goes high during a program or erase operation, writing the reset command returns the device to reading array data (also applies during Erase Suspend).

#### **Autoselect Command Sequence**

The autoselect command sequence allows the host system to access the manufacturer and devices codes, and determine whether or not a sector is protected. The Command Definitions table shows the address and data requirements. This method is an alternative to that shown in the Autoselect

Codes (High Voltage Method) table, which is intended for PROM programmers and requires Vid on address bit A9.

The autoselect command sequence is initiated by writing two unlock cycles, followed by the autoselect command. The device then enters the autoselect mode, and the system may read at any address any number of times, without initiating another command sequence.

A read cycle at address XX00h retrieves the manufacturer code and another read cycle at XX11h retrieves the continuation code. A read cycle at address XX01h returns the device code.

A read cycle containing a sector address (SA) and the address 02h in returns 01h if that sector is protected, or 00h if it is unprotected. Refer to the Sector Address tables for valid sector addresses. When a Read occurs at an address within the 16Kbyte boot sector (SA34 for the top boot devices and SA0 for the bottom boot devices), the input on the  $\overline{\text{WP}}$  pin may determine what code is returned.

16Kbyte Sector Protection	WP Input	Autoselect Code
Protected	Vін	01 (Protected)
Protected	VIL	01 (Protected)
Unprotected	Vıн	00 (Unprotected)
Unprotected	VIL	01 (Protected) <sup>1</sup>

Note 1. Sector is protected from erasure. Programming within the sector is still permitted.

The system must write the reset command to exit the autoselect mode and return to reading array data.

#### **Word/Byte Program Command Sequence**

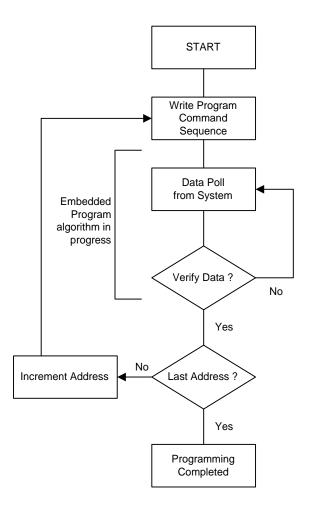
The system may program the device by word or byte, depending on the state of the BYTE pin. Programming is a four-bus-cycle operation. The program command sequence is initiated by writing two unlock write cycles, followed by the program set-up command. The program address and data are written next, which in turn initiate the Embedded Program algorithm. The system is not required to provide further controls or timings. The device automatically provides internally generated program pulses and verify the programmed cell margin. Table 9 shows the address and data requirements for the byte program command sequence.

When the Embedded Program algorithm is complete, the device then returns to reading array data and addresses are longer latched. The system can determine the status of the program operation by using I/O<sub>7</sub>, I/O<sub>6</sub>, or RY/BY. See "White Operation Status" for information on these status bits.

Any commands written to the device during the Embedded Program Algorithm are ignored. Note that a hardware reset immediately terminates the programming operation. The Byte Program command sequence should be reinitiated once the device has reset to reading array data, to ensure data integrity.

Programming is allowed in any sequence and across sector boundaries. A bit cannot be programmed from a "0" back to a "1". Attempting to do so may halt the operation and set I/O5 to "1", or cause the Data Polling algorithm to indicate the operation was successful. However, a succeeding read will show that the data is still "0". Only erase operations can convert a "0" to a "1".





Note: See the appropriate Command Definitions table for program command sequence.

Figure 3. Program Operation

## **Unlock Bypass Command Sequence**

The unlock bypass feature allows the system to program bytes or words to the device faster than using the standard program command sequence. The unlock bypass command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle containing the unlock bypass command, 20h. The device then enters the unlock bypass mode. A two-cycle unlock bypass program command sequence is all that is required to program in this mode. The first cycle in this sequence contains the unlock bypass program command, A0h; the second cycle contains the program address and data. Additional data is programmed in the same manner. This mode dispenses with the initial two unlock cycles required in the standard program command sequence, resulting in faster total programming time. Table 9 shows the requirements for the command sequence.

During the unlock bypass mode, only the Unlock Bypass Program and Unlock Bypass Reset commands are valid. To exit the unlock bypass mode, the system must issue the two-cycle unlock bypass reset command sequence. The first cycle must contain the data 90h; the second cycle the data

00h. Addresses are don't care for both cycle. The device returns to reading array data.

Figure 3 illustrates the algorithm for the program operation. See the Erase/Program Operations in "AC Characteristics" for parameters, and to Program Operation Timings for timing diagrams.

#### **Chip Erase Command Sequence**

Chip erase is a six-bus-cycle operation. The chip erase command sequence is initiated by writing two unlock cycles, followed by a set-up command. Two additional unlock write cycles are then followed by the chip erase command, which in turn invokes the Embedded Erase algorithm. The device does not require the system to preprogram prior to erase. The Embedded Erase algorithm automatically preprograms and verifies the entire memory for an all zero data pattern prior to electrical erase. The system is not required to provide any controls or timings during these operations. The Command Definitions table shows the address and data requirements for the chip erase command sequence.

Any commands written to the chip during the Embedded Erase algorithm are ignored. The system can determine the status of the erase operation by using I/O<sub>7</sub>, I/O<sub>6</sub>, or I/O<sub>2</sub>. See "Write Operation Status" for information on these status bits. When the Embedded Erase algorithm is complete, the device returns to reading array data and addresses are no longer latched.

Figure 4 illustrates the algorithm for the erase operation. See the Erase/Program Operations tables in "AC Characteristics" for parameters, and to the Chip/Sector Erase Operation Timings for timing waveforms.

#### **Sector Erase Command Sequence**

Sector erase is a six-bus-cycle operation. The sector erase command sequence is initiated by writing two unlock cycles, followed by a set-up command. Two additional unlock write cycles are then followed by the address of the sector to be erased, and the sector erase command. The Command Definitions table shows the address and data requirements for the sector erase command sequence.

The device does not require the system to preprogram the memory prior to erase. The Embedded Erase algorithm automatically programs and verifies the sector for an all zero data pattern prior to electrical erase. The system is not required to provide any controls or timings during these operations.

After the command sequence is written, a sector erase timeout of  $50\mu s$  begins. During the time-out period, additional sector addresses and sector erase commands may be written. Loading the sector erase buffer may be done in any sequence, and the number of sectors may be from one sector to all sectors. The time between these additional cycles must be less than 50 µs, otherwise the last address and command might not be accepted, and erasure may begin. It is recommended that processor interrupts be disabled during this time to ensure all commands are accepted. The interrupts can be re-enabled after the last Sector Erase command is written. If the time between additional sector erase commands can be assumed to be less than 50 µs, the system need not monitor I/O3. Any command other than Sector Erase or Erase Suspend during the time-out period resets the device to reading array data. The system must rewrite the command sequence and any additional sector addresses and commands.



The system can monitor I/O $_3$  to determine if the sector erase timer has timed out. (See the "I/O $_3$ : Sector Erase Timer" section.) The time-out begins from the rising edge of the final  $\overline{\text{WE}}$  pulse in the command sequence.

Once the sector erase operation has begun, only the Erase Suspend command is valid. All other commands are ignored. When the Embedded Erase algorithm is complete, the device returns to reading array data and addresses are no longer latched. The system can determine the status of the erase operation by using I/O<sub>7</sub>, I/O<sub>6</sub>, or I/O<sub>2</sub>. Refer to "Write Operation Status" for information on these status bits.

Figure 4 illustrates the algorithm for the erase operation. Refer to the Erase/Program Operations tables in the "AC Characteristics" section for parameters, and to the Sector Erase Operations Timing diagram for timing waveforms.

#### **Erase Suspend/Erase Resume Commands**

The Erase Suspend command allows the system to interrupt a sector erase operation and then read data from, or program data to, any sector not selected for erasure. This command is valid only during the sector erase operation, including the 50µs time-out period during the sector erase command sequence. The Erase Suspend command is ignored if written during the chip erase operation or Embedded Program algorithm. Writing the Erase Suspend command during the Sector Erase time-out immediately terminates the time-out period and suspends the erase operation. Addresses are "don't cares" when writing the Erase Suspend command.

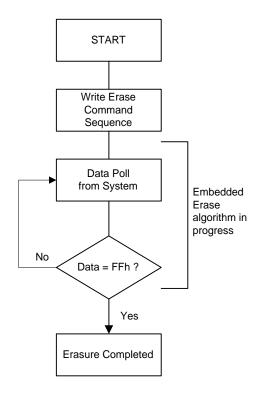
When the Erase Suspend command is written during a sector erase operation, the device requires a maximum of  $20\mu s$  to suspend the erase operation. However, when the Erase Suspend command is written during the sector erase time-out, the device immediately terminates the time-out period and suspends the erase operation.

After the erase operation has been suspended, the system can read array data from or program data to any sector not selected for erasure. (The device "erase suspends" all sectors selected for erasure.) Normal read and write timings and command definitions apply. Reading at any address within erase-suspended sectors produces status data on I/Or - I/Oo. The system can use I/O7, or I/O6 and I/O2 together, to determine if a sector is actively erasing or is erase-suspended. See "Write Operation Status" for information on these status bits.

After an erase-suspended program operation is complete, the system can once again read array data within non-suspended sectors. The system can determine the status of the program operation using the  $I/O_7$  or  $I/O_6$  status bits, just as in the standard program operation. See "Write Operation Status" for more information.

The system may also write the autoselect command sequence when the device is in the Erase Suspend mode. The device allows reading autoselect codes even at addresses within erasing sectors, since the codes are not stored in the memory array. When the device exits the autoselect mode, the device reverts to the Erase Suspend mode, and is ready for another valid operation. See "Autoselect Command Sequence" for more information.

The system must write the Erase Resume command (address bits are "don't care") to exit the erase suspend mode and continue the sector erase operation. Further writes of the Resume command are ignored. Another Erase Suspend command can be written after the device has resumed erasing.



- 1. See the appropriate Command Definitions table for erase command sequences.
- 2. See "I/O3: Sector Erase Timer" for more information.

Figure 4. Erase Operation



Table 9. A29160A Command Definitions

Note 1)   O					s 2 - 5)	(Notes	ycles	Bus C					SS		Command		
Read (Note 6)	Sixth	Ş	Fifth		ourth	F	hird	Т	cond	Se	First	F	ycle		•		
Reset (Note 7)	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	้ว		(Note 1)		
Manufacturer ID											RD	RA	1		Read (Note 6)		
Manufacturer ID   Byte   4   AAA   AA   555   55   AAA   90   X00   37											F0	XXX	1		Reset (Note 7)		
Byte   AAA   S55   AAA   AA					37	X00	90		55		АА		4		Manufacturer ID		
Top Boot Block   Byte   4   AAA   AA   555   55   AAA   90   X02   A8							- 00				, , ,		•	•			
Top Boot Block   Byte   AAA   S55   AAA   AAA   S55   AAA   AAA							90		55		AA		4				
CFI Query (Note 10)   Word   Byte   AAA   AAA   S55   AAA   S55   AAA   PD   CFI Query (Note 10)   Byte   AAA															ω Tob Boot Block		
CFI Query (Note 10)   Byte   AAA   AAA   S555   AAA   Byte   AAA   AAA							90		55		ΔΔ		4		Device ID,		
CFI Query (Note 10)   Byte   4   AAA   AAA   555   AAA   A					29		00		00		701				Z Bottom Boot Block Byte		
CFI Query (Note 10)   Byte   4   AAA   AAA   555   AAA   90   X02   XX01					7F		90		55		ΔΔ		4		り Continuation ID		
CFI Query (Note 10)   Byte   4   AAA   AAA   555   AAA   A					/ 1	X06	50	AAA	55	555	701	AAA	т	Byte	Sell Sell Sell Sell Sell Sell Sell Sell		
CFI Query (Note 10)   Word   Byte   AAA   AAA   S55   AAA   S55   AAA   PD   CFI Query (Note 10)   Byte   AAA					XX00	(SA)									nto		
Byte   AAA     555   AAA					XX01			555		2AA		555		Word	Occion i lotect verily		
Byte   AAA   555   AAA   X04   01					00	(\$4)	90		55		AA		4		(Note 9)		
CFI Query (Note 10)         Word Byte         1         55 AA         98								AAA		555		AAA		Byte			
Program         Word Byte         4         555 AAA         AA         2AA S55         555 AAA         AAA         AAA AAA         AAAA         AAAA         AAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAA					<u> </u>							55		Word			
Program         Word Byte         4         555 AAA         AA         2AA 55 555 AAA         AA         PA PD           Unlock Bypass         Word Byte         3 AAA         555 AAA         55 55 AAA         2AA 55 555 AAA         2AA 55 555 AAA         2AA 55 555 AAA         2AA AAAA         2AA AAAA         2AA AAAA         2AA AAAA         2AAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAAA											98		1		CFI Query (Note 10)		
Unlock Bypass         Word Byte         3         555 AAA         655 AAAA         655 AAAAA         655 AAAAA         655 AAAAAA         65					PD	PA	A0	555	55	2AA	Λ Λ	555	4		Dua 2112 122		
Unlock Bypass Program (Note 2 XXX A0 PA PD 11)								AAA		555	AA	AAA	4	Byte	Program		
Unlock Bypass Program (Note 2 XXX A0 PA PD 11)							20	555	55	2AA	Λ Λ	555	٠	Word	Halada Damasa		
11)								AAA		555	AA	AAA	3	Byte	Unlock Bypass		
11.1.1.5. 5. (41.1.10) 0. (20.1.10) 0. (20.1.10)									PD	PA	A0	XXX	2	n (Note	Unlock Bypass Program (Not		
Uniock Bypass Reset (Note 12)   2   XXX  90   XXX   00									00	XXX	90	XXX	2	e 12)	Unlock Bypass Reset (Note 12)		
Word 555 2AA 55 555 80 555 AA 2AA 55 555	10	555	55	2AA	AA	555	80	555	55	2AA	Λ Λ				,		
Chip Erase         Byte         6         AAA         AA         555         AAA         AAA         555         AAA		AAA		555		AAA		AAA		555	AA	AAA	р	Byte	Unip Erase		
Sector Erase	30	SA	55	2AA	AA	555	80	555	55		ΛΛ		6	Word	Soctor Eraco		
Byte 6 AAA AA 555 AAA AAA 555				555		AAA		AAA		555	AA	AAA	Ö	Byte	Seciol Elase		
Erase Suspend (Note 13) 1 XXX B0											B0	XXX	1	)	Erase Suspend (Note 13)		
Erase Resume (Note 14) 1 XXX 30											30	XXX	1				

#### Legend:

X = Don't care

RA = Address of the memory location to be read.

RD = Data read from location RA during read operation.

PA = Address of the memory location to be programmed. Addresses latch on the falling edge of the  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$  pulse, whichever happens later.

PD = Data to be programmed at location PA. Data latches on the rising edge of WE or CE pulse, whichever happens first.

SA = Address of the sector to be verified (in autoselect mode) or erased. Address bits A19 - A12 select a unique sector.

- 1. See Table 1 for description of bus operations.
- 2. All values are in hexadecimal.
- 3. Except when reading array or autoselect data, all bus cycles are write operation.
- 4. Address bits A19 A11 are don't cares for unlock and command cycles, unless SA or PA required.
- 5. No unlock or command cycles required when reading array data.
- 6. The Reset command is required to return to reading array data when device is in the autoselect mode, or if I/Os goes high (while the device is providing status data).
- 7. The fourth cycle of the autoselect command sequence is a read cycle.
- 8. The data is 00h for an unprotected sector and 01h for a protected sector. See "Autoselect Command Sequence" for more information.
- The data is 00h for an unprotected sector and 01h for a protected sector. See "Autoselect Command Sequence" for more information.
- 10. Command is valid when device is ready to read array data or when device is in autoselect mode.
- 11. The Unlock Bypass command is required prior to the Unlock Bypass Program command.
- 12. The Unlock Bypass Reset command is required to return to reading array data when the device is in the unlock bypass mode.
- 13. The system may read and program in non-erasing sectors, or enter the autoselect mode, when in the Erase Suspend mode.
- 14. The Erase Resume command is valid only during the Erase Suspend mode.



#### **Write Operation Status**

Several bits, I/O<sub>2</sub>, I/O<sub>3</sub>, I/O<sub>5</sub>, I/O<sub>6</sub>, I/O<sub>7</sub>, RY/ $\overline{BY}$  are provided in the A29160A to determine the status of a write operation. Table 10 and the following subsections describe the functions of these status bits. I/O<sub>7</sub>, I/O<sub>6</sub> and RY/ $\overline{BY}$  each offer a method for determining whether a program or erase operation is complete or in progress. These three bits are discussed first.

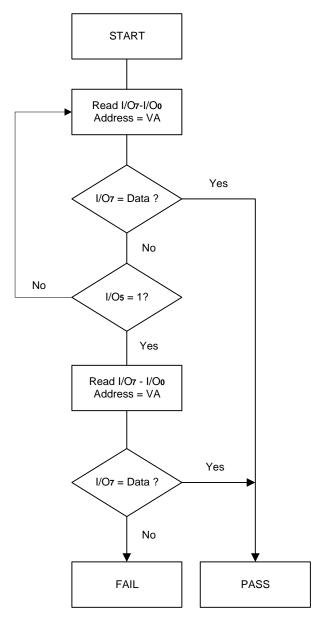
#### I/O7: Data Polling

The Data Polling bit, I/O<sub>7</sub>, indicates to the host system whether an Embedded Algorithm is in progress or completed, or whether the device is in Erase Suspend. Data Polling is valid after the rising edge of the final WE pulse in the program or erase command sequence.

During the Embedded Program algorithm, the device outputs on I/O7 the complement of the datum programmed to I/O7. This I/O7 status also applies to programming during Erase Suspend. When the Embedded Program algorithm is complete, the device outputs the datum programmed to I/O7. The system must provide the program address to read valid status information on I/O7. If a program address falls within a protected sector,  $\overline{Data}$  Polling on I/O7 is active for approximately  $2\mu s$ , then the device returns to reading array data.

During the Embedded Erase algorithm, Data Polling produces a "0" on I/O7. When the Embedded Erase algorithm is complete, or if the device enters the Erase Suspend mode, Data Polling produces a "1" on I/O7. This is analogous to the complement/true datum output described for the Embedded Program algorithm: the erase function changes all the bits in a sector to "1"; prior to this, the device outputs the "complement," or "0." The system must provide an address within any of the sectors selected for erasure to read valid status information on I/O7.

After an erase command sequence is written, if all sectors selected for erasing are protected,  $\overline{Data}$  Polling on I/O7 is active for approximately  $100\mu s$ , then the device returns to reading array data. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected. When the system detects I/O7 has changed from the complement to true data, it can read valid data at I/O7 - I/O6 on the following read cycles. This is because I/O7 may change asynchronously with I/O6 - I/O6 while Output Enable ( $\overline{OE}$ ) is asserted low. The  $\overline{Data}$  Polling Timings (During Embedded Algorithms) figure in the "AC Characteristics" section illustrates this. Table 10 shows the outputs for  $\overline{Data}$  Polling on I/O7. Figure 5 shows the  $\overline{Data}$  Polling algorithm.



#### Note

- VA = Valid address for programming. During a sector erase operation, a valid address is an address within any sector selected for erasure. During chip erase, a valid address is any non-protected sector address.
- 2. I/O7 should be rechecked even if I/O5 = "1" because I/O7 may change simultaneously with I/O5.

Figure 5. Data Polling Algorithm



#### RY/BY: Read/Busy

The RY/ $\overline{BY}$  is a dedicated, open-drain output pin that indicates whether an Embedded algorithm is in progress or complete. The RY/ $\overline{BY}$  status is valid after the rising edge of the final  $\overline{WE}$  pulse in the command sequence. Since RY/ $\overline{BY}$  is an open-drain output, several RY/ $\overline{BY}$  pins can be tied together in parallel with a pull-up resistor to VCC.

If the output is low (Busy), the device is actively erasing or programming. (This includes programming in the Erase Suspend mode.) If the output is high (Ready), the device is ready to read array data (including during the Erase Suspend mode), or is in the standby mode.

Table 10 shows the outputs for RY/BY. Refer to "RESET Timings", "Timing Waveforms for Program Operation" and "Timing Waveforms for Chip/Sector Erase Operation" for more information.

### I/O6: Toggle Bit I

Toggle Bit I on I/O6 indicates whether an Embedded Program or Erase algorithm is in progress or complete, or whether the device has entered the Erase Suspend mode. Toggle Bit I may be read at any address, and is valid after the rising edge of the final WE pulse in the command sequence (prior to the program or erase operation), and during the sector erase time-out.

During an Embedded Program or Erase algorithm operation, successive read cycles to any address cause I/O6 to toggle. (The system may use either  $\overline{OE}$  or  $\overline{CE}$  to control the read cycles.) When the operation is complete, I/O6 stops toggling. After an erase command sequence is written, if all sectors selected for erasing are protected, I/O6 toggles for approximately  $100\mu s$ , then returns to reading array data. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected.

The system can use I/O<sub>6</sub> and I/O<sub>2</sub> together to determine whether a sector is actively erasing or is erase-suspended. When the device is actively erasing (that is, the Embedded Erase algorithm is in progress), I/O<sub>6</sub> toggles. When the device enters the Erase Suspend mode, I/O<sub>6</sub> stops toggling. However, the system must also use I/O<sub>2</sub> to determine which sectors are erasing or erase-suspended. Alternatively, the system can use I/O<sub>7</sub> (see the subsection on " I/O<sub>7</sub>:  $\overline{Data}$  Polling").

If a program address falls within a protected sector, I/O6 toggles for approximately  $2\mu s$  after the program command sequence is written, then returns to reading array data.

I/O<sub>6</sub> also toggles during the erase-suspend-program mode, and stops toggling once the Embedded Program algorithm is complete.

The Write Operation Status table shows the outputs for Toggle Bit I on I/O6. Refer to Figure 6 for the toggle bit algorithm, and to the Toggle Bit Timings figure in the "AC Characteristics" section for the timing diagram. The I/O2 vs. I/O6 figure shows the differences between I/O2 and I/O6 in graphical form. See also the subsection on "I/O2: Toggle Bit

#### I/O2: Toggle Bit II

The "Toggle Bit II" on I/O2, when used with I/O6, indicates whether a particular sector is actively erasing (that is, the Embedded Erase algorithm is in progress), or whether that sector is erase-suspended. Toggle Bit II is valid after the rising edge of the final  $\overline{WE}$  pulse in the command sequence. I/O2 toggles when the system reads at addresses within those sectors that have been selected for erasure. (The system may use either  $\overline{OE}$  or  $\overline{CE}$  to control the read cycles.) But I/O2 cannot distinguish whether the sector is actively erasing or is erase-suspended. I/O6, by comparison, indicates whether the device is actively erasing, or is in Erase Suspend, but cannot distinguish which sectors are selected for erasure. Thus, both status bits are required for sector and mode information. Refer to Table 10 to compare outputs for I/O2 and I/O6.

Figure 6 shows the toggle bit algorithm in flowchart form, and the section " I/O<sub>2</sub>: Toggle Bit II" explains the algorithm. See also the " I/O<sub>6</sub>: Toggle Bit I" subsection. Refer to the Toggle Bit Timings figure for the toggle bit timing diagram. The I/O<sub>2</sub> vs. I/O<sub>6</sub> figure shows the differences between I/O<sub>2</sub> and I/O<sub>6</sub> in graphical form.

#### Reading Toggle Bits I/O6, I/O2

Refer to Figure 6 for the following discussion. Whenever the system initially begins reading toggle bit status, it must read I/O7 - I/O0 at least twice in a row to determine whether a toggle bit is toggling. Typically, a system would note and store the value of the toggle bit after the first read. After the second read, the system would compare the new value of the toggle bit with the first. If the toggle bit is not toggling, the device has completed the program or erase operation. The system can read array data on I/O<sub>7</sub> - I/O<sub>0</sub> on the following read cycle. However, if after the initial two read cycles, the system determines that the toggle bit is still toggling, the system also should note whether the value of I/O<sub>5</sub> is high (see the section on I/O<sub>5</sub>). If it is, the system should then determine again whether the toggle bit is toggling, since the toggle bit may have stopped toggling just as I/Os went high. If the toggle bit is no longer toggling, the device has successfully completed the program or erase operation. If it is still toggling, the device did not complete the operation successfully, and the system must write the reset command to return to reading array data. The remaining scenario is that the system initially determines that the toggle bit is toggling and I/O<sub>5</sub> has not gone high. The system may continue to monitor the toggle bit and I/O<sub>5</sub> through successive read cycles, determining the status as described in the previous paragraph. Alternatively, it may choose to perform other system tasks. In this case, the system must start at the beginning of the algorithm when it returns to determine the status of the operation (top of Figure

#### I/O<sub>5</sub>: Exceeded Timing Limits

I/Os indicates whether the program or erase time has exceeded a specified internal pulse count limit. Under these conditions I/Os produces a "1." This is a failure condition that indicates the program or erase cycle was not successfully completed.



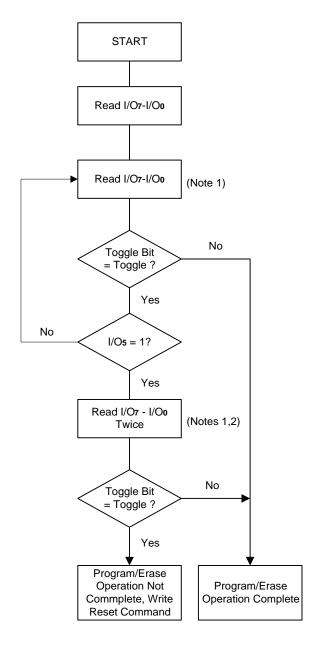
The I/O $_5$  failure condition may appear if the system tries to program a "1 "to a location that is previously programmed to "0." Only an erase operation can change a "0" back to a "1." Under this condition, the device halts the operation, and when the operation has exceeded the timing limits, I/O $_5$  produces a "1."

Under both these conditions, the system must issue the reset command to return the device to reading array data.

#### I/O3: Sector Erase Timer

After writing a sector erase command sequence, the system may read I/O3 to determine whether or not an erase operation has begun. (The sector erase timer does not apply to the chip erase command.) If additional sectors are selected for erasure, the entire time-out also applies after each additional sector erase command. When the time-out is complete, I/O3 switches from "0" to "1." The system may ignore I/O3 if the system can guarantee that the time between additional sector erase commands will always be less than  $50\mu s$ . See also the "Sector Erase Command Sequence" section.

After the sector erase command sequence is written, the system should read the status on I/O7 (Data Polling) or I/O6 (Toggle Bit 1) to ensure the device has accepted the command sequence, and then read I/O3. If I/O3 is "1", the internally controlled erase cycle has begun; all further commands (other than Erase Suspend) are ignored until the erase operation is complete. If I/O3 is "0", the device will accept additional sector erase commands. To ensure the command has been accepted, the system software should check the status of I/O3 prior to and following each subsequent sector erase command. If I/O3 is high on the second status check, the last command might not have been accepted. Table 10 shows the outputs for I/O3.



- Read toggle bit twice to determine whether or not it is toggling. See text.
- Recheck toggle bit because it may stop toggling as I/O5 changes to "1". See text.

Figure 6. Toggle Bit Algorithm



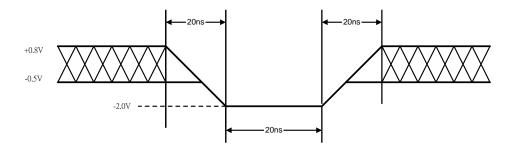
Table	10	Write	On	<u> eration</u>	<b>Status</b>
Iable	ıv.	AALIFE	VΡ	<del>c</del> ı alıvı	Status

	Operation	I/O <sub>7</sub>	I/O <sub>6</sub>	I/O <sub>5</sub>	I/O <sub>3</sub>	I/O <sub>2</sub>	RY/BY
	- F <b>2.1.6</b>			(Note 2)		(Note 1)	
Standard Mode	Embedded Program Algorithm	Ī/O <sub>7</sub>	Toggle	0	N/A	No toggle	0
Wiode	Embedded Erase Algorithm	0	Toggle	0	1	Toggle	0
Erase Suspend	Reading within Erase Suspended Sector	1	No toggle	0	N/A	Toggle	1
Mode	Reading within Non-Erase Suspend Sector	Data	Data	Data	Data	Data	1
	Erase-Suspend-Program	Ī/O <sub>7</sub>	Toggle	0	N/A	N/A	0

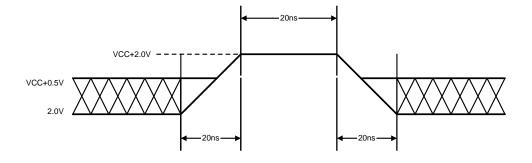
#### Notes:

- 1. I/O<sub>7</sub> and I/O<sub>2</sub> require a valid address when reading status information. Refer to the appropriate subsection for further details.
- 2. I/Os switches to "1" when an Embedded Program or Embedded Erase operation has exceeded the maximum timing limits. See "I/O5: Exceeded Timing Limits" for more information.

# **Maximum Negative Input Overshoot**



## **Maximum Positive Input Overshoot**





## **DC Characteristics**

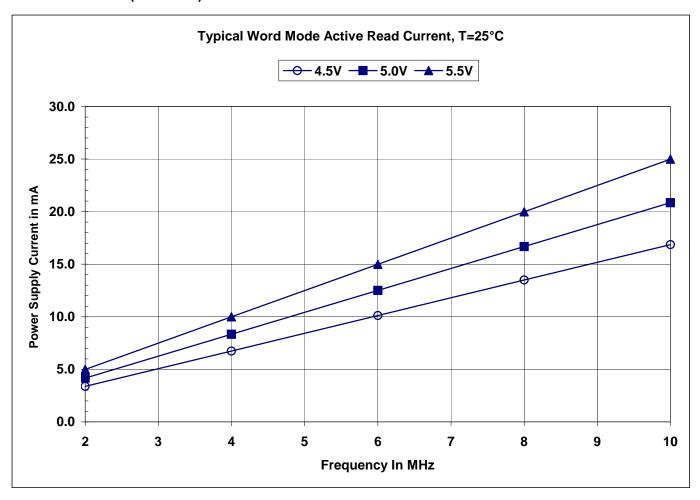
# **CMOS Compatible**

Parameter Symbol	Parameter Description	Test Description	Min.	Тур.	Max.	Unit	
lu	Input Leakage Current	VIN = VSS to VCC. VCC = VC			±2.0	μΑ	
Ішт	A9 Input Load Current	VCC = VCC Max, A9 =11.5V				35	μΑ
lLo	Output Leakage Current	Vout = VSS to VCC. VCC = V	CC Max			±2.0	μΑ
		$\overline{CE} = V_{IL}, \overline{OE} = V_{IH}$ 5 MHz			8	40	
	VCC Active Read Current	Byte Mode	1 MHz		1.6	8	
lcc1	(Notes 1, 2)	$\overline{CE} = VIL, \overline{OE} = VIH$	5 MHz		12	50	mA
		Word Mode		2.4	10		
lcc2	VCC Active Write (Program/Erase) Current (Notes 2, 3, 4)	CE = VIL, OE =VIH		30	50	mA	
lcc3	VCC Standby Current (Note 2)	$\overline{CE} = VIH, \ \overline{RESET} = VCC \pm 0$	.5V		0.5	10	uA
	, ,	WP = VCC or Float					
Icc4	VCC Standby Current During Reset	$\overline{RESET} = VSS \pm 0.5V$			5	10	μΑ
	(Note 2)	WP = VCC or Float					
VIL	Input Low Level			-0.5		0.8	V
Vih	Input High Level			2.0		VCC + 0.5	V
VID	Voltage for Autoselect and Temporary Unprotect Sector	VCC = 5.0 V		9.5	10.5	11.5	V
Vol	Output Low Voltage	IoL = 6.0mA, VCC = VCC Min			0.45	V	
Voн1	0	Іон = -2.5 mA, VCC = VCC M	0.8 x VCC			V	
Voн2	Output High Voltage	Іон = -100 μA, VCC = VCC M	in	VCC - 0.4			V
Vlko	Low VCC Lockout Voltage (Note 5)			3.1	3.6	4.1	V

- 1. The lcc current listed is typically less than 2 mA/MHz, with  $\overline{\text{OE}}$  at Vih. Typical VCC is 5.0V.
- 2. Maximum Icc specifications are tested with VCC = VCC max.
- 3. Icc active while Embedded Algorithm (program or erase) is in progress.
- 4. Not 100% tested.



# **DC Characteristics (continued)**



# AC Characteristics

# **Read Only Operations**

Parameter	Symbols	Descript	ion	Test Setup		Sp	eed	Unit
JEDEC	Std					-55	-70	
tavav	trc	Read Cycle Time (Note	e 1)		Min.	55	70	ns
tavqv	tacc	Address to Output Delay		CE = VIL OE = VIL	Max.	55	70	ns
telqv	tcE	Chip Enable to Output Delay		OE = VIL	Max.	55	70	ns
tgLQV	toE	Output Enable to Outp	ut Delay		Max.	25	30	ns
		Outset Frankla Hald	Read		Min.	0	0	ns
	tоен	Output Enable Hold Time (Note 1)  Toggle and Data Polling			Min.	10	10	ns
tenqz	tor	Chip Disable to Output High Z (Notes 1)			Max.	20	20	ns
tgнqz	tor	Output Disable to Outp (Notes 1)	out High Z		Max.	20	20	ns

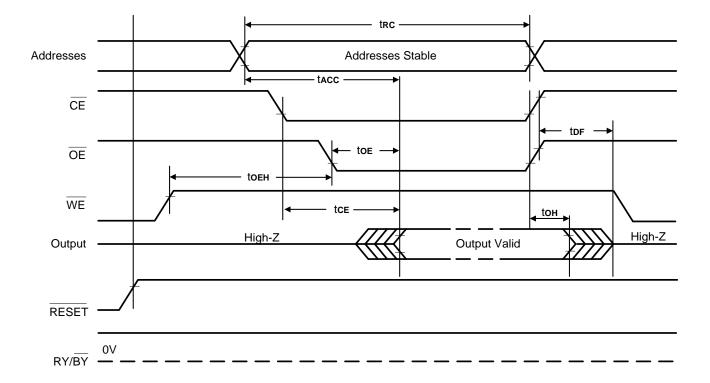


taxqx	toн	Output Hold Time from Addresses,  CE or OE, Whichever Occurs First (Note 1)		Min.	0	0	ns	
-------	-----	---	--	------	---	---	----	--

#### Notes:

- 1. Not 100% tested.
- 2. See Test Conditions and Test Setup for test specifications.

# **Timing Waveforms for Read Only Operation**





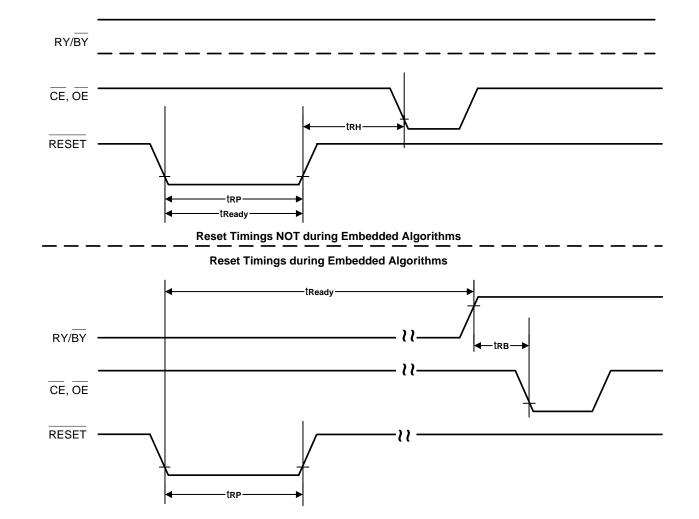
# **AC Characteristics**

# Hardware Reset (RESET)

Paran	neter	Description	Test S	Setup	All Speed Options	Unit
JEDEC	Std	·		•		
	TREADY RESET Pin Low (During Embedded Algorithms) to Read or Write (See Note)			Max	20	μS
	TREADY RESET Pin Low (Not During Embedded Algorithms) to Read or Write (See Note)			Max	500	ns
	trp	RESET Pulse Width		Min	500	ns
	trн	RESET High Time Before Read (See Note)		Min	50	ns
	trв	RY/BY Recovery Time		Min	0	ns
	trpd	RESET Low to Standby Mode		Min	20	μS

Note: Not 100% tested.

# **RESET** Timings



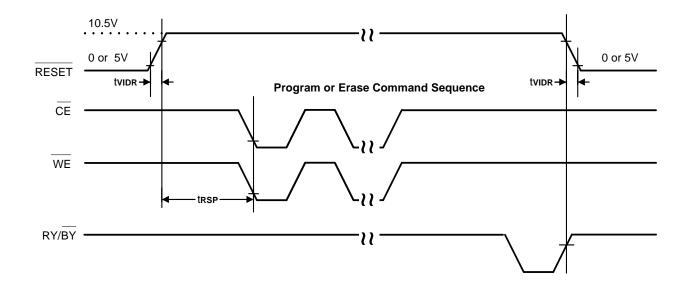


# **Temporary Sector Unprotect**

Parameter		Description	Description		
JEDEC	Std			All Speed Options	Unit
	tvidr	VID Rise and Fall Time (See Note)		500	ns
	trsp	RESET Setup Time for Temporary Sector Unprotect	Min	4	μS

Note: Not 100% tested.

# **Temporary Sector Unprotect Timing Diagram**



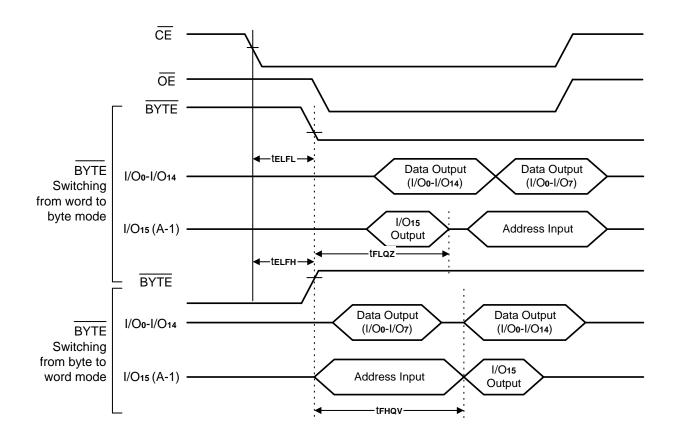
# **AC Characteristics**

# Word/Byte Configuration (BYTE)

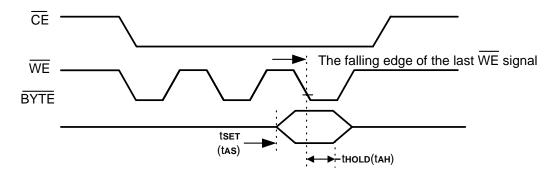
Para	meter	Description		All Speed Options		Unit
JEDEC	Std			-55 -70		
	telfl/telfh	CE to BYTE Switching Low or High	Max	5		ns
	trlqz	BYTE Switching Low to Output High-Z	Max	25	25	ns
	thqv	BYTE Switching High to Output Active	Min	55 70		ns



# **BYTE** Timings for Read Operations



# **BYTE** Timings for Write Operations



#### Note:

Refer to the Erase/Program Operations table for tas and tan specifications.



# **AC Characteristics**

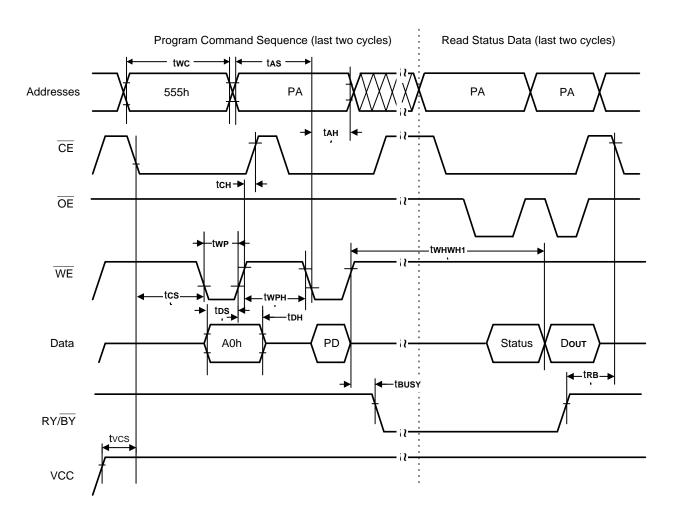
# **Erase and Program Operations**

Parai	meter	Description	n		Sp	peed	Unit
JEDEC	Std			-55	-70		
tavav	twc	Write Cycle Time (Note 1)		Min.	55	70	ns
tavwl	tas	Address Setup Time		Min.		0	ns
twLax	tан	Address Hold Time		Min.	40	40	ns
tоvwн	tos	Data Setup Time		Min.	30	30	ns
twndx	tрн	Data Hold Time		Min.		0	ns
	toes	Output Enable Setup Time		Min.		0	ns
tgнwL	tghwL	Read Recover Time Before Write (OE high to WE low)	Min.	0		ns	
telwl	tcs	CE Setup Time	Min.		0	ns	
twhen	tсн	CE Hold Time		Min.		0	ns
twLwH	twp	Write Pulse Width		Min.	35	35	ns
twhwL	twрн	Write Pulse Width High		Min.	20		ns
4	<b>4</b>	Byte Programming Operation	Byte	Тур.	6		
twhwh1	twhwh1	(Note 2)	Тур.	1	1	μS	
twhwh2	twnwh2	Sector Erase Operation (Note 2)	Тур.	0.7		sec	
	tvcs	VCC Set Up Time (Note 1)	Min.	50		μS	
	trв	Recovery Time from RY/BY	Min		0	ns	
	tвusy	Program/Erase Valid to RY/BY D	elay	Min	30	30	ns

- 1. Not 100% tested.
- 2. See the "Erase and Programming Performance" section for more information.



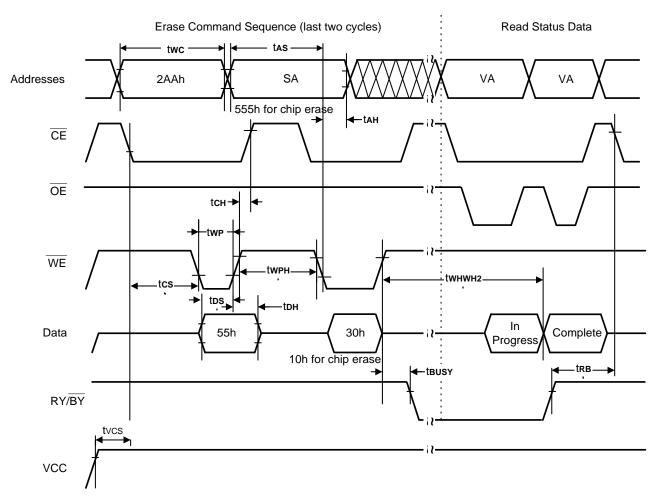
# **Timing Waveforms for Program Operation**



- 1. PA = program addrss, PD = program data, Dout is the true data at the program address.
- 2. Illustration shows device in word mode.



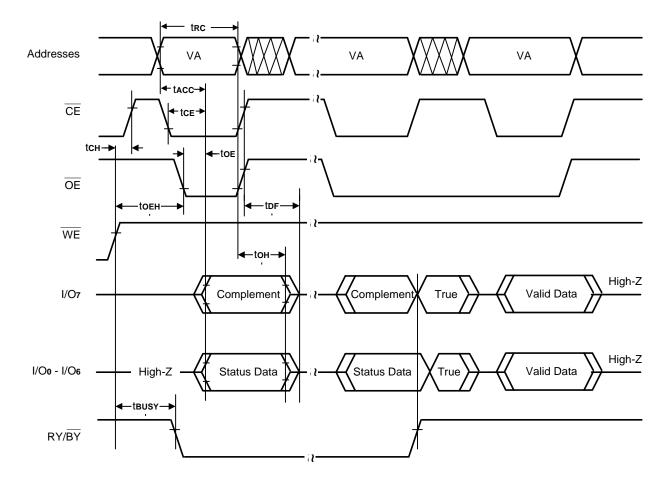
# **Timing Waveforms for Chip/Sector Erase Operation**



- 1. SA = Sector Address (for Sector Erase), VA = Valid Address for reading status data (see "Write Operaion Ststus").
- 2. Illustratin shows device in word mode.



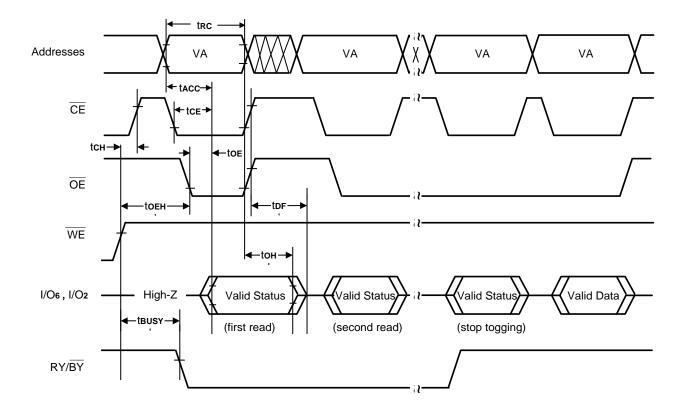
# Timing Waveforms for Data Polling (During Embedded Algorithms)



Note: VA = Valid Address. Illustation shows first status cycle after command sequence, last status read cycle, and array data read cycle.



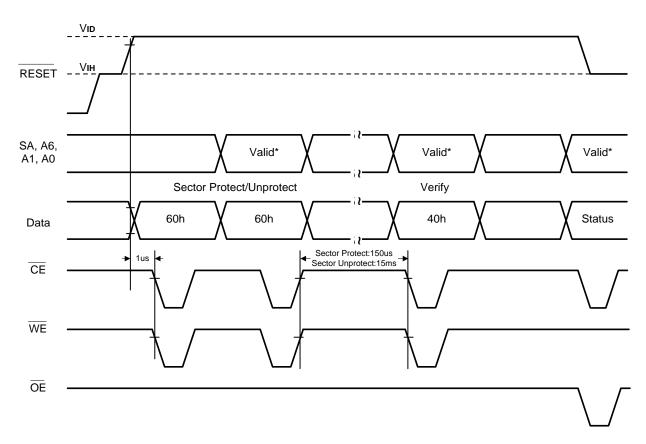
# **Timing Waveforms for Toggle Bit (During Embedded Algorithms)**



Note: VA = Valid Address; not required for I/O<sub>6</sub>. Illustration shows first two status cycle after command sequence, last status read cycle, and array data read cycle.

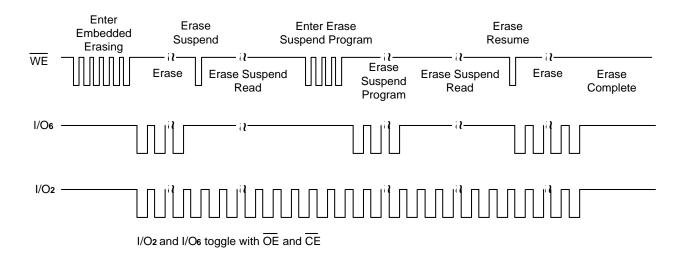


## **Timing Waveforms for Sector Protect/Unprotect**



Note: For sector protect, A6=0, A1=1, A0=0. For sector unprotect, A6=1, A1=1, A0=0

## Timing Waveforms for I/O2 vs. I/O6



Note: Both I/Os and I/O2 toggle with OE or CE. See the text on I/Os and I/O2 in the section "Write Operation Status" for more information.



# AC Characteristics Erase and Program Operations

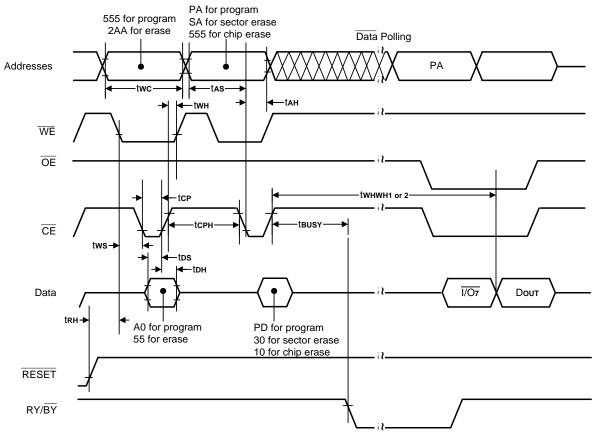
Alternate CE Controlled Writes

Parai	meter	Descrip	otion		Spe	eed	Unit
JEDEC	Std				-55	-70	
tavav	twc	Write Cycle Time (Note 1)		Min.	55	70	ns
tavel	tas	Address Setup Time		Min.	С		ns
telax	tah	Address Hold Time		Min.	40	40	ns
toven	tos	Data Setup Time		Min.	30	30	ns
tehdx	tон	Data Hold Time		Min.	С		ns
	toes	Output Enable Setup Time		Min.	0		ns
tghel	tghel	Read Recover Time Before V	Vrite	Min.	0		ns
twlel	tws	WE Setup Time		Min.	O	)	ns
tenwn	twн	WE Hold Time		Min.	О	)	ns
teleh	tcp	CE Pulse Width		Min.	35 35		ns
tehel	tсрн	CE Pulse Width High		Min.	20		ns
twnwh1	twnwn1	Programming Operation	Byte	Тур.	6		μS
LWHWH1	(WHWH1	(Note 2)	Word	Тур.	11		
twnwh2	twnwH2	Sector Erase Operation (Note	e 2)	Тур.	0.	7	sec

- 1. Not 100% tested.
- 2. See the "Erase and Programming Performance" section for more information.



## Timing Waveforms for Alternate CE Controlled Write Operation



#### Note:

- 1. PA = Program Address, PD = Program Data, SA = Sector Address, 1/Θ = Complement of Data Input, Douτ = Array Data.
- 2. Figure indicates the last two bus cycles of the command sequence.

#### **Erase and Programming Performance**

Parameter	Parameter		Max. (Note 2)	Unit	Comments
Sector Erase Time		0.7	3.5	sec	Excludes 00h programming
Chip Erase Time	Chip Erase Time			sec	prior to erasure
Byte Programming Time	rte Programming Time		200	μs	
Word Programming Time		11	360	μS	Excludes system-level
Chip Programming Time	nip Programming Time Byte Mode		40	sec	overhead (Note 5)
(Note 3)	Word Mode	12	36	sec	

- 1. Typical program and erase times assume the following conditions: 25°C, 5.0V VCC, 10,000 cycles. Additionally, programming typically assumes checkerboard pattern.
- 2. Under worst case conditions of  $90^{\circ}$ C, VCC = 4.5V, 100,000 cycles.
- 3. The typical chip programming time is considerably less than the maximum chip programming time listed, since most bytes program faster than the maximum byte program time listed. If the maximum byte program time given is exceeded, only then does the device set I/O<sub>5</sub> = 1. See the section on I/O<sub>5</sub> for further information.
- 4. In the pre-programming step of the Embedded Erase algorithm, all bytes are programmed to 00h before erasure.
- 5. System-level overhead is the time required to execute the four-bus-cycle command sequence for programming. See Table 9 for further information on command definitions.
- 6. The device has a guaranteed minimum erase and program cycle endurance of 100,000 cycles.



# **Latch-up Characteristics**

Description	Min.	Max.
Input Voltage with respect to VSS on all I/O pins	-1.0V	VCC+1.0V
VCC Current	-100 mA	+100 mA
Input voltage with respect to VSS on all pins except I/O pins	-1.0V	11.5V
(including A9, $\overline{OE}$ and $\overline{RESET}$ )		

Includes all pins except VCC. Test conditions: VCC = 5.0V, one pin at time.

# **TSOP Pin Capacitance**

Parameter Symbol	Parameter Description	Test Setup	Тур.	Max.	Unit
Cin	Input Capacitance	Vin=0	6	7.5	pF
Соит	Output Capacitance	Vоит=0	8.5	12	pF
CIN2	Control Pin Capacitance	Vin=0	7.5	9	pF

- 1. Sampled, not 100% tested.
- 2. Test conditions T<sub>A</sub> = 25°C, f = 1.0MHz

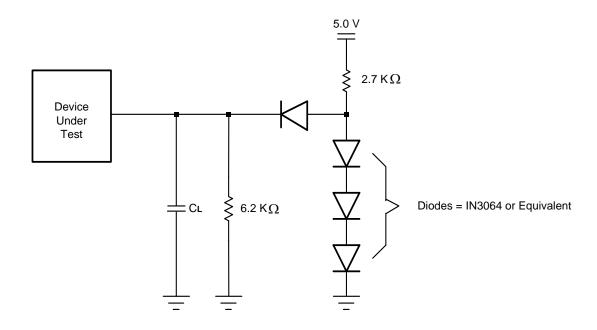


# **Test Conditions**

**Test Specifications** 

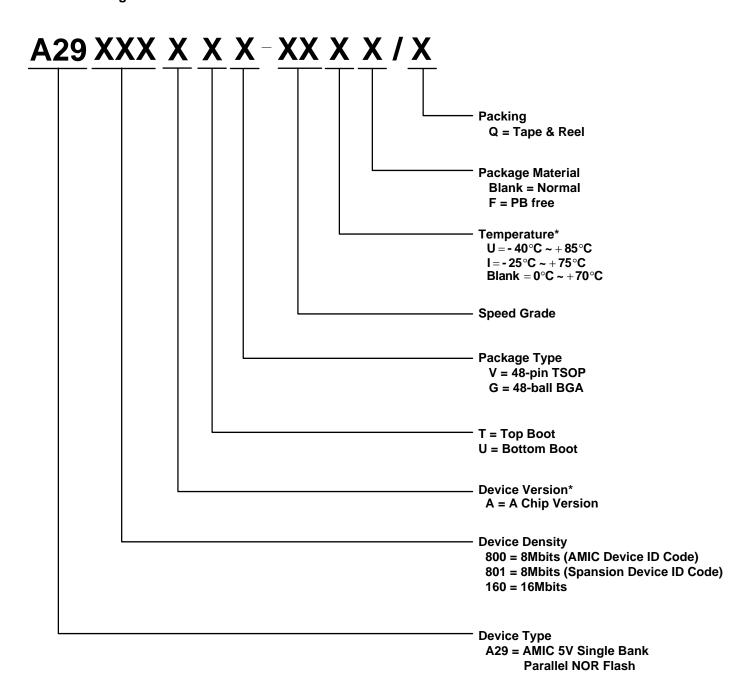
Test Condition	-55	-70	Unit
Output Load	1 TTL gate		
Output Load Capacitance, CL (including jig capacitance)	30	30	pF
Input Rise and Fall Times	5	5	ns
Input Pulse Levels	0.0 - 3.0	0.0 - 3.0	V
Input timing measurement reference levels	1.5	1.5	V
Output timing measurement reference levels	1.5	1.5	V

# **Test Setup**





**Part Numbering Scheme** 



\* Optional



# Ordering Information Top Boot Sector Flash

Part No.	Access Time (ns)	Active Read Current Typ. (mA)	Program/Erase Current Typ. (mA)	Standby Current Typ. (μΑ)	Package				
A29160ATV-55F		20			48 Pin Pb-Free TSOP				
A29160ATV-55UF	55		30	0.5	48 Pin Pb-Free TSOP				
A29160ATG-55F	55		30		48-ball Pb-Free TFBGA				
A29160ATG-55UF					48-ball Pb-Free TFBGA				
A29160ATV-70F		00				48 Pin Pb-Free TSOP			
A29160ATV-70UF			00	0.5	48 Pin Pb-Free TSOP				
A29160ATG-70F	70	20	30	0.5	48-ball Pb-Free TFBGA				
A29160ATG-70UF									48-ball Pb-Free TFBGA

<sup>-</sup>U is for industrial operating temperature range: -40°C to +85°C.

## **Bottom Boot Sector Flash**

Part No.	Access Time (ns)	Active Read Current Typ. (mA)	Program/Erase Current Typ. (mA)	Standby Current Typ. (μΑ)	Package			
A29160AUV-55F		20 30 0.5 48 Pin		0.5	48 Pin Pb-Free TSOP			
A29160AUV-55UF	55		20		48 Pin Pb-Free TSOP			
A29160AUG-55F	55		30 0.5	48-ball Pb-Free TFBGA				
A29160AUG-55UF					48-ball Pb-Free TFBGA			
A29160AUV-70F								48 Pin Pb-Free TSOP
A29160AUV-70UF	70 20 30	0.5	48 Pin Pb-Free TSOP					
A29160AUG-70F		20	20	20	70 20	30	0.5	48-ball Pb-Free TFBGA
A29160AUG-70UF					48-ball Pb-Free TFBGA			

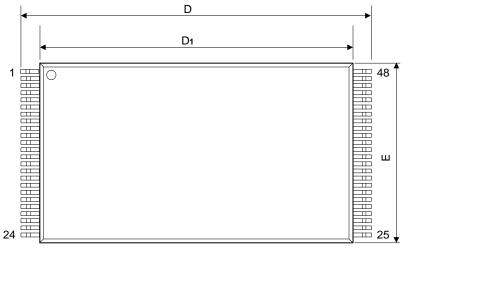
<sup>-</sup>U is for industrial operating temperature range: -40°C to +85°C.

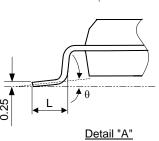


# **Package Information**

# TSOP 48L (Type I) Outline Dimensions

unit: inches/mm





Detail "A"	

Symbol	Dimensions in inches			Dimensions in mm		
Syllibol	Min	Nom	Max	Min	Nom	Max
Α	-	-	0.047	-	-	1.20
A1	0.002	-	0.006	0.05	-	0.15
A2	0.037	0.039	0.042	0.94	1.00	1.06
b	0.007	0.009	0.011	0.18	0.22	0.27
С	0.004	-	0.008	0.12	-	0.20
D	0.779	0.787	0.795	19.80	20.00	20.20
D1	0.720	0.724	0.728	18.30	18.40	18.50
Е	-	0.472	0.476	-	12.00	12.10
е	0.	.020 BASI	С	0.50 BASIC		С
L	0.020	0.024	0.0275	0.50	0.60	0.70
S	0.011 Typ.		0.28 Typ.			
у	-	-	0.004	-	-	0.10
θ	0°	_	8°	0°	-	8°

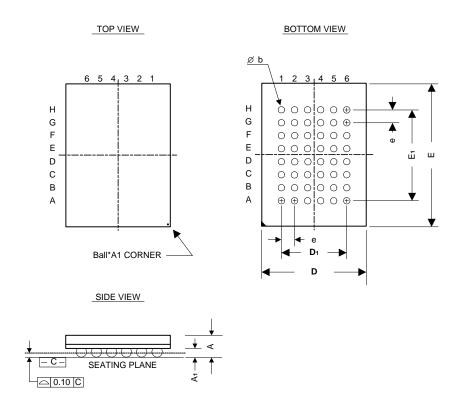
- 1. The maximum value of dimension D includes end flash.
- 2. Dimension E does not include resin fins.
- 3. Dimension S includes end flash.



## **Package Information**

# 48 Balls CSP (6 x 8 mm) Outline Dimensions (48TFBGA)

unit: mm



Cumbal	Dimensions in mm			
Symbol	Min.	Nom.	Max.	
Α	1	-	1.20	
A1	0.20	0.25	0.30	
b	0.30	-	0.40	
D	5.90	6.00	6.10	
D1	4.00 BSC			
е	-	0.80	-	
Е	7.90	8.00	8.10	
E <sub>1</sub>	5.60 BSC			